Olan (TM15") Block Diagram

Project code: 91.4Z701.001
PCB P/N : 48.4Z701.0SB
REVISION : 07249-SB

DDR2 667/800 MHz 8,9
DDR2 667/800 MHz 8,9
667/800MHz
667/800MHz
AMD Giffin CPU S1G2 (35W)
638-Pin uFCPGA638
4,5,6,7
OUT
IN
16X16
G792 25
CLK GEN.
SILEGO SLG8SP628 3
North Bridge
AMD RS780M
CPU I/F LVDS, CRT I/F
INTEGRATED GRAHPICS
11,12,13
A-Link 4X4
PCIex16
CRT 18
LCD 16
HDMI 19
VGA Borad 37
45,46
CRT
DVI
RJ45
Port Replicator
LAN
Giga LAN BCM5764M 35
TXFM 36
RJ45 36
New card 38
PWR SW TPS2231 38
Mini Card Kedron a/b/g/n 39
PCIex1
Line In 42
MIC In 42
42
Line Out (No-SPDIF)
Codec CX20561 40
AZALIA
South Bridge
AMD SB700
USB 2.0/1.1 ports
ETHERNET (10/100/1000Mb)
High Definition Audio
ATA 66/100
ACPI 1.1
LPC I/F
PCI/PCI BRIDGE
20,21,22,23,24
MS/MS Pro/xD /MMC/SD/SD IO 5 in 1 33
Cardbus OZ711MZ 32
PCMCIA SLOT 34
PCI
LPC BUS
USB
SATA
42
INT.SPKR
OP AMP APA2031 41
RJ11
MODEM MDC Card 29
HDD SATA 27
ODD SATA 26
Mini USB Blue Tooth 28
Finger Printer 31
Camera
USB 4 Port 30
KBC Winbond WPC775 43
BIOS Winbond W25X80 44
Launch Buttom 15
Touch Pad 43
INT. KB 43
LPC DEBUG CONN. 44
USBX4
HP OUT
MIC IN
LINE IN

PCB STACKUP

TOP
VCC
S
S
GND
BOTTOM

SYSTEM DC/DC TPS51125 51	
INPUTS	OUTPUTS
DCBATOUT	5V_S5(7A) 3D3V_S5(7A)

SYSTEM DC/DC TPS51124 52	
INPUTS	OUTPUTS
DCBATOUT	1D1V_S0(9A) 1D2V_S0(5A)

SYSTEM DC/DC TPS51117 53	
INPUTS	OUTPUTS
DCBATOUT	1D8V_S3(10A)

RT9026PFP 54	
5V_S5	DDR_VREF_S3 0D9V_S3

RT9166 54	
3D3V_S0	2D5V_S0 (300mA)

G957 54	
3D3V_S0	1D5V_S0 (1A)

G9161 54	
3D3V_S5	1D2V_S5 (400mA)

CHARGER BQ24745 55	
INPUTS	OUTPUTS
DCBATOUT	CHG_PWR 18V 6.0A UP+5V 5V 100mA

CPU DC/DC ISL6265HR 50	
INPUTS	OUTPUTS
DCBATOUT	VCC_CORE_S0_0 0~1.55V 18A VCC_CORE_S0_1 0~1.55V 18A VDDNB 0~1.55V 18A

DIS DOCK

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: BLOCK DIAGRAM
Size: A3 | Document Number: Olan | Rev: SB
Date: Thursday, January 10, 2008 | Sheet 1 of 57

DATE	VERSON	ITEM	PAGE	Modify List	Issue Description	OWNER
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DIS DOCK

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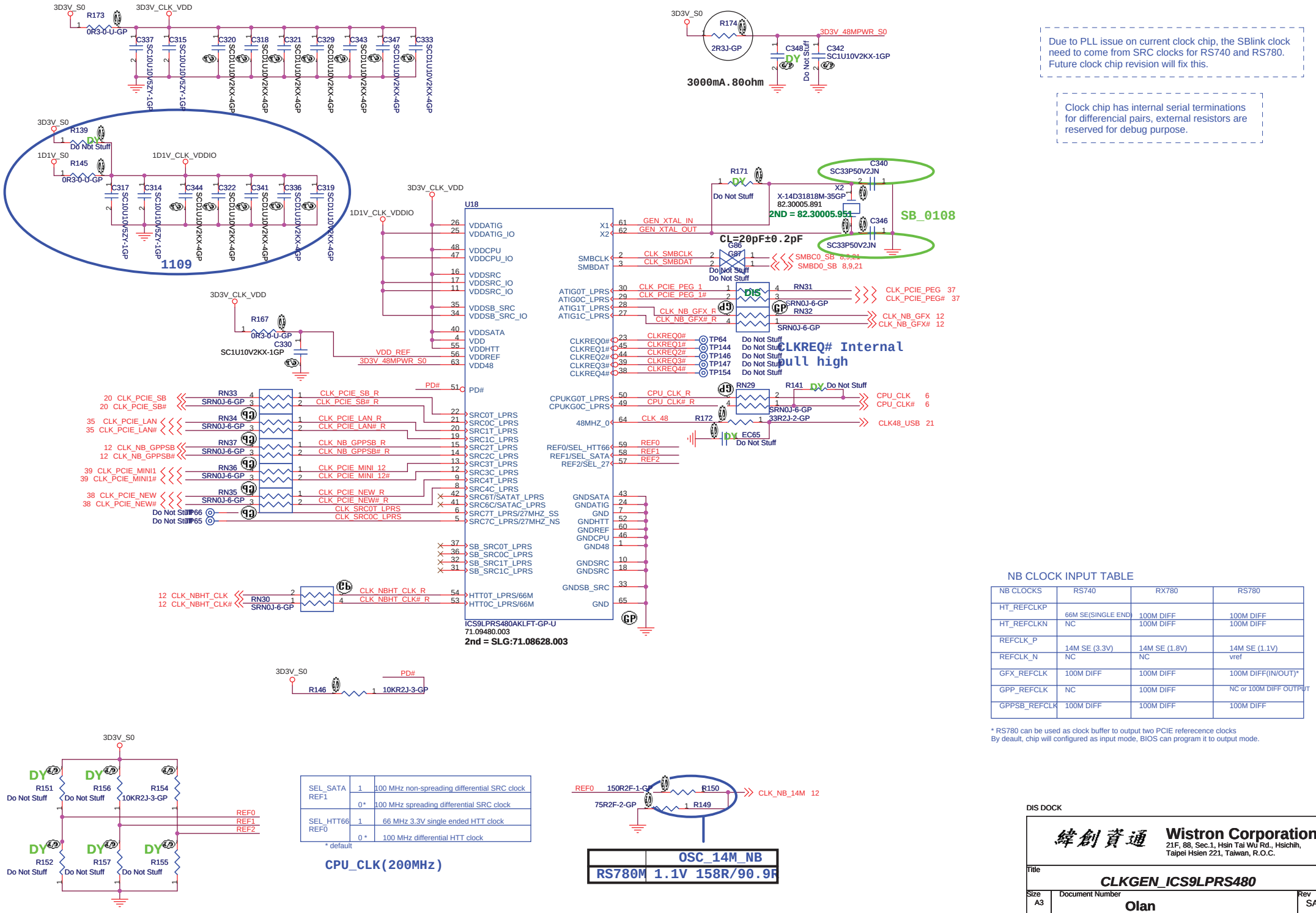
Title: ***HISTORY***

Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 2 of 57



NB CLOCK INPUT TABLE

NB CLOCKS	RS740	RX780	RS780
HT_REFCLKP	66M SE(SINGLE END)	100M DIFF	100M DIFF
HT_REFCLKN	NC	100M DIFF	100M DIFF
REFCLK_P	14M SE (3.3V)	14M SE (1.8V)	14M SE (1.1V)
REFCLK_N	NC	NC	vref
GFX_REFCLK	100M DIFF	100M DIFF	100M DIFF(IN/OUT)*
GPP_REFCLK	NC	100M DIFF	NC or 100M DIFF OUTPUT
GPPSB_REFCLK	100M DIFF	100M DIFF	100M DIFF

* RS780 can be used as clock buffer to output two PCIE referecence clocks
By deault, chip will configured as input mode, BIOS can program it to output mode.

DIS DOCK

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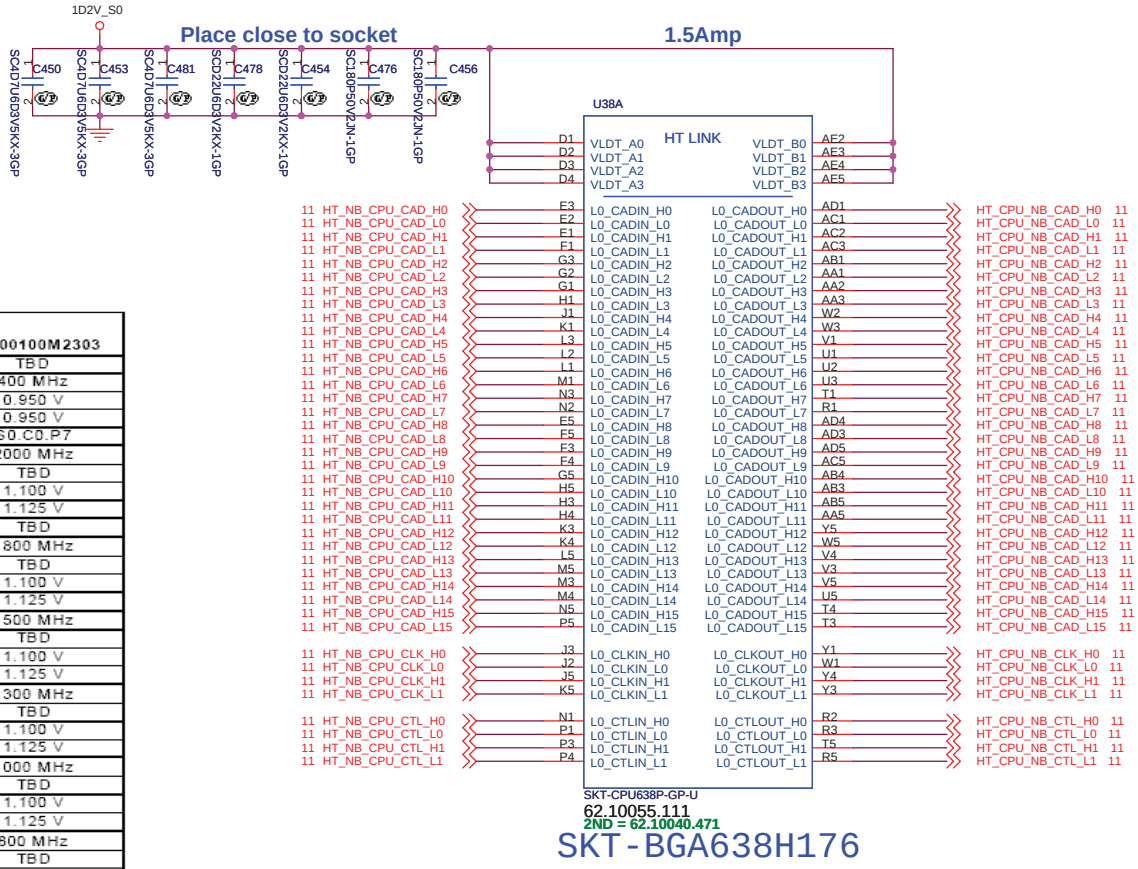
Title: CLKGEN_ICS9LPRS480

Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 3 of 57



State	Specification	Notes	2M200100M2303
S0.C0.Px	Tcase Max	3	TBD
	NB COF	1	400 MHz
	VID_VDDNB Min	2	0.950 V
	VID_VDDNB Max	2	0.950 V
	Startup P-state		S0.C0.P7
S0.C0.P0	CPU COF	1	2000 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
	IDD Max	3	TBD
S0.C0.P1	CPU COF	1	1800 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P2	CPU COF	1	1500 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P3	CPU COF	1	1300 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P4	CPU COF	1	1000 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P5	CPU COF	1	800 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P6	CPU COF	1	500 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V
S0.C0.P7	CPU COF	1	300 MHz
	TDP	3	TBD
	VID_VDD Min	2	1.100 V
	VID_VDD Max	2	1.125 V

DIS DOCK

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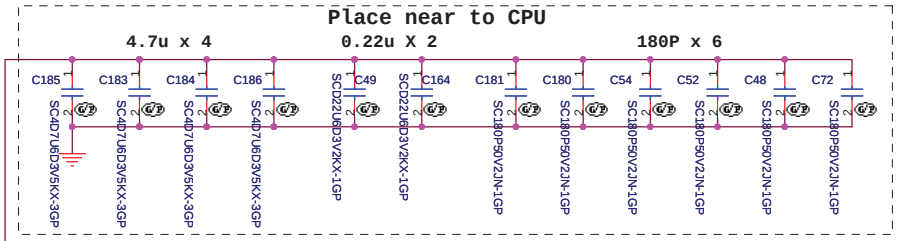
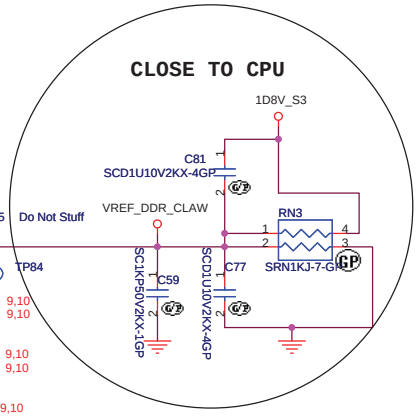
Taipei Hsien 221, Taiwan, R.O.C.

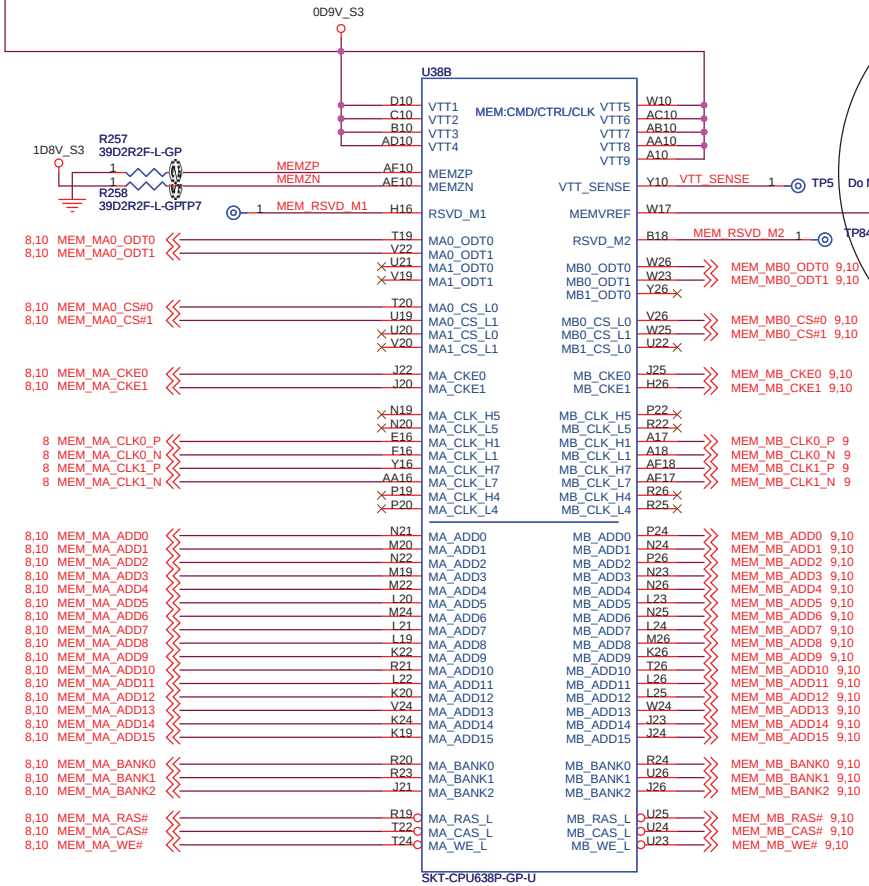
Title: CPU_HT_LINK I/F_(1/4)

Size: A3 | Document Number: Olan | Rev: SA

Date: Thursday, January 10, 2008 | Sheet 4 of 57







DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	***CPU_DDR_(2/4)***	
Size: A3	Document Number: **Olan**	Rev: SA
Date: Thursday, January 10, 2008	Sheet 5 of 57	

The Processor has reached a preset maximum operating temperature. 100℃
I=Active HTC
O=FAN

IF 0 ohm IS NOT GOOD ENOUGH, TRY 68.00082.491

LYAOUT:ROUTE VDDA TRACE APPROX. 50mils WIDE(USE 2X25 mil TRACES TO EXIT BALL FIELD) AND 500 mils LONG.

SB with 0402 PAD

Cloce To CPU

For HDT DBG

internal pull high 300 ohm

LAYOUT: Route FBCLKOUT_H/L differentially impedance 80

Near CPU PIN

CPU exceeds 125℃

HDT Connectors

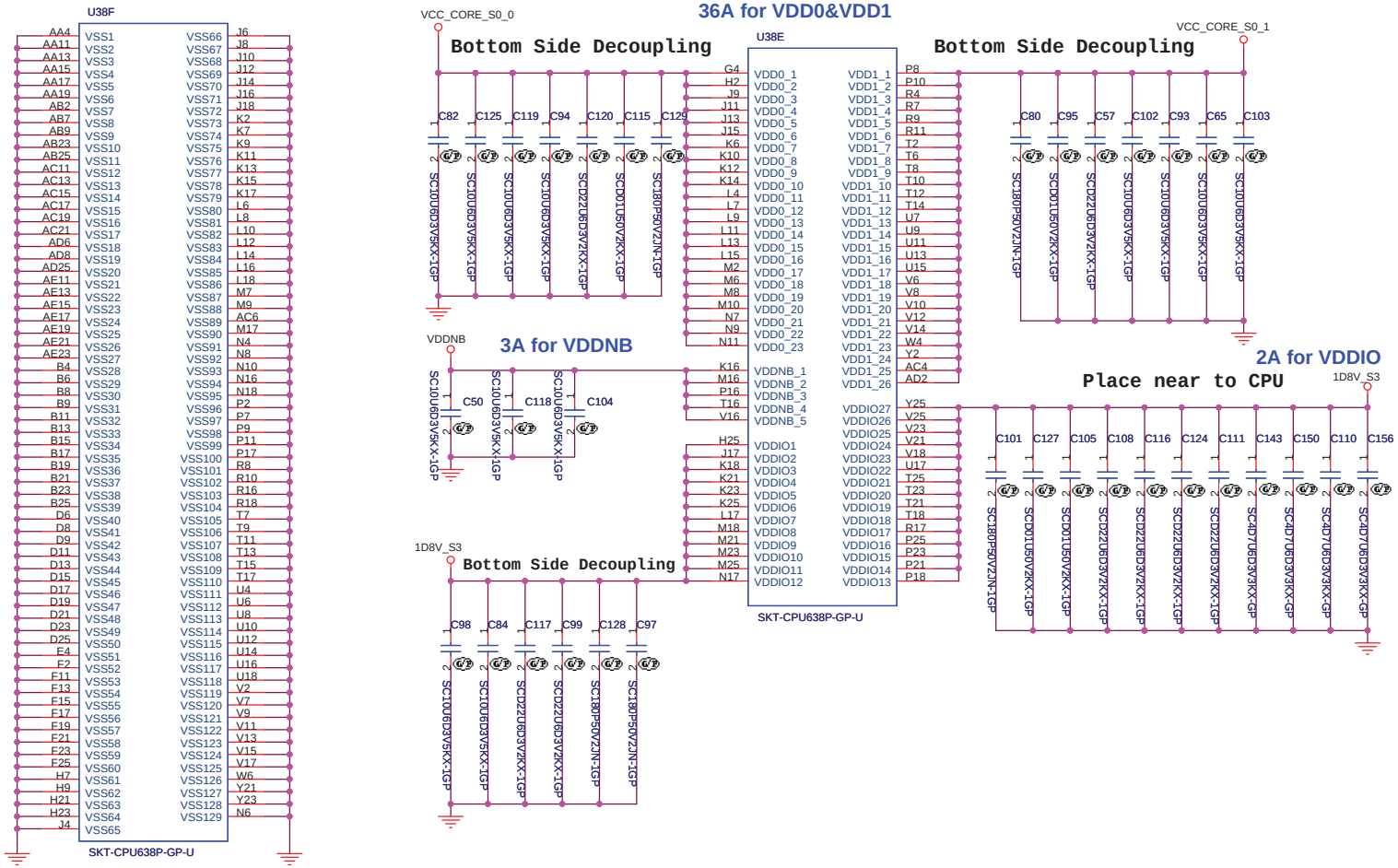
DIS DOCK

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: CPU_Control&Debug_(3/4)

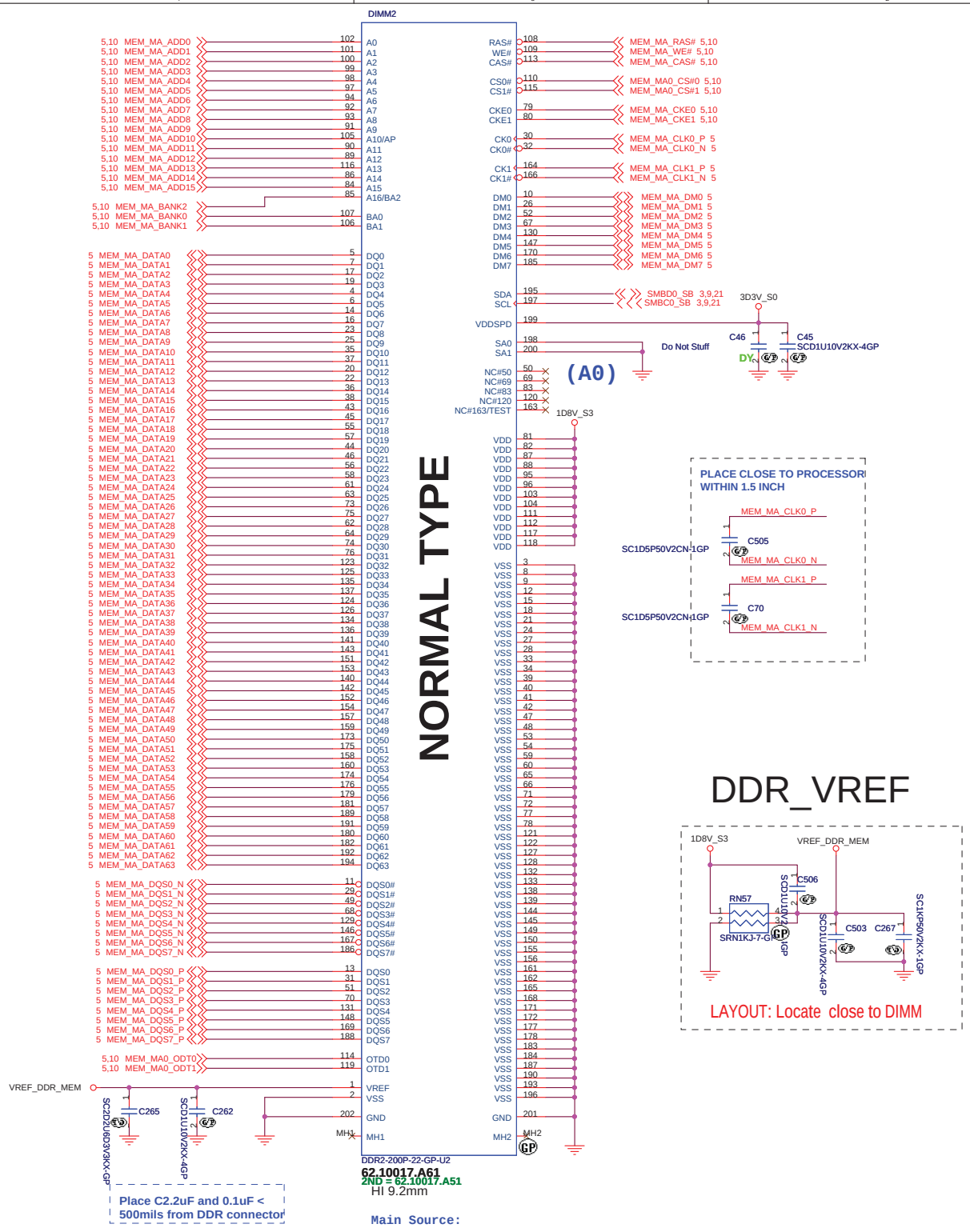
Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 6 of 57



DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
Title	***CPU_Power_(4/4)***
Size: A3	Document Number: **Olan**
Rev: SA	
Date: Thursday, January 10, 2008	Sheet 7 of 57



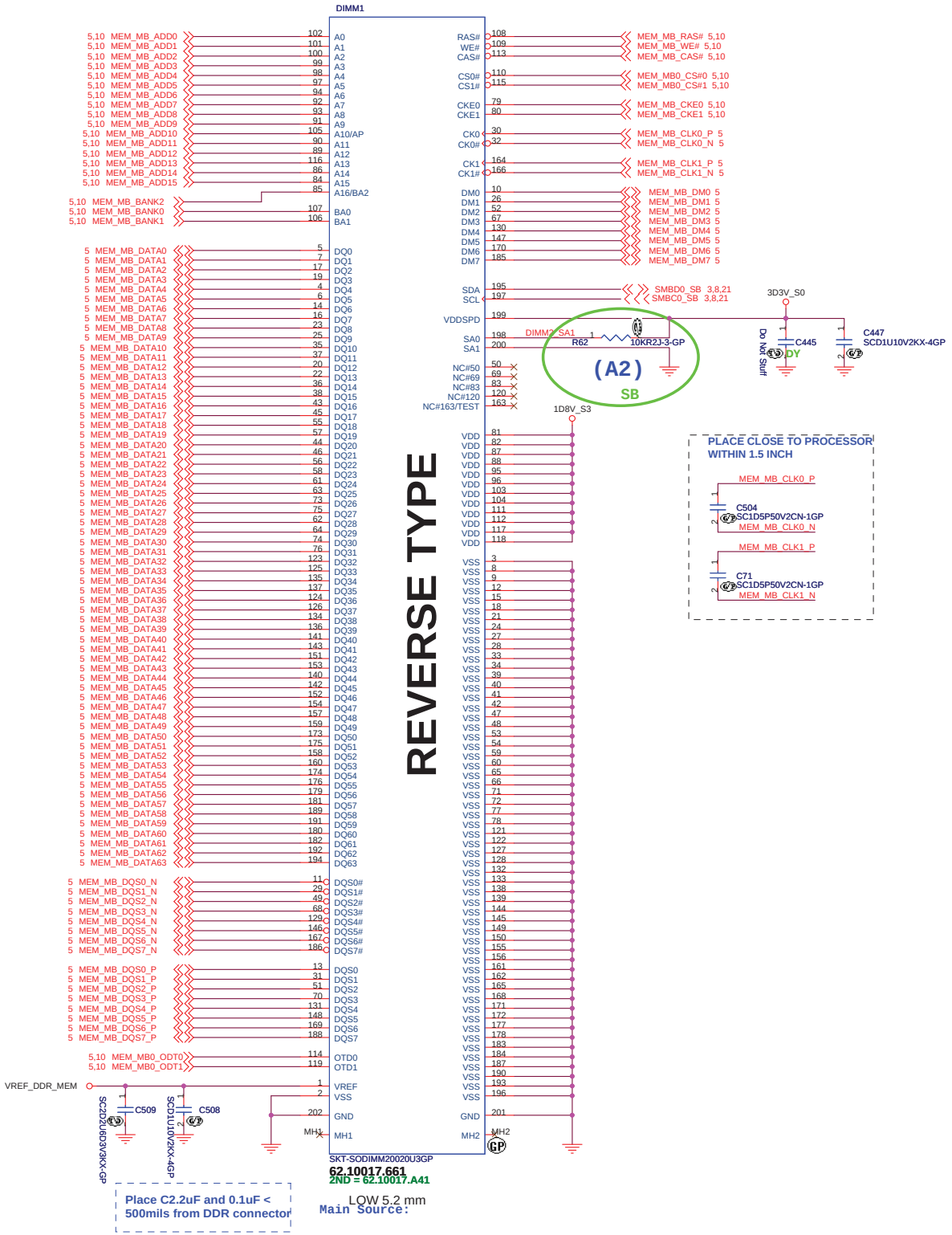
DIS DOCK

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: DDR_SO-DIMM SKT_1

Size	Document Number	Rev
Custom	Olan	SA

Date: Thursday, January 10, 2008 Sheet 8 of 57



DIS DOCK

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

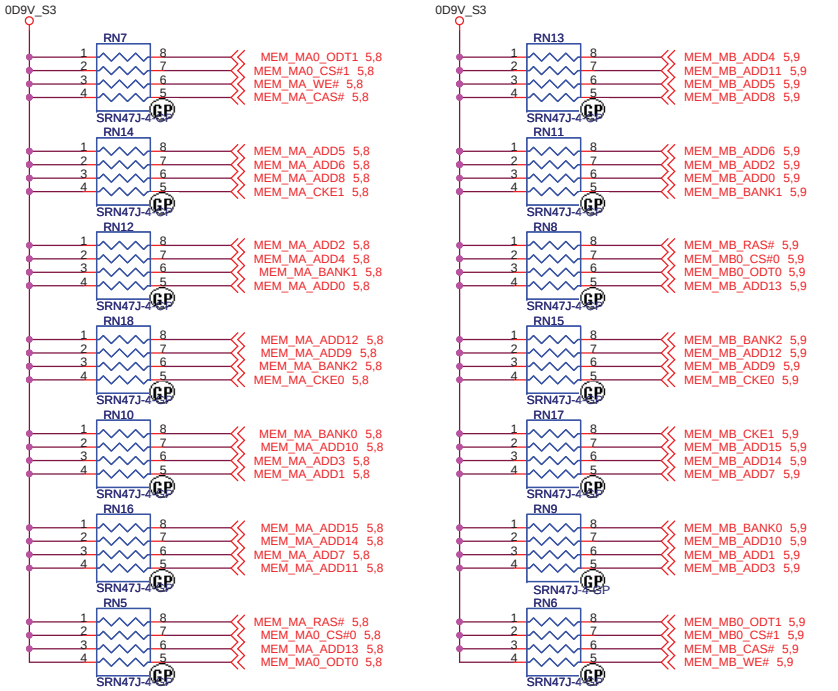
Title: ***DDR_SO-DIMM SKT_2***

Size: Custom | Document Number: Olan | Rev: SA

Date: Thursday, January 10, 2008 | Sheet 9 of 57

PARALLEL TERMINATION

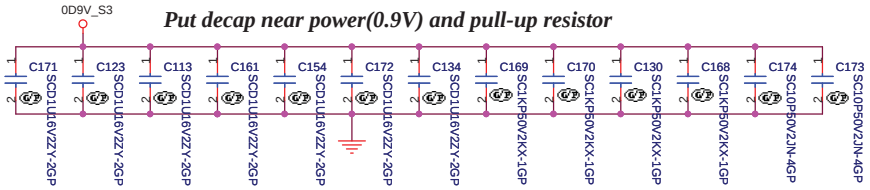
Put decap near power(0.9V) and pull-up resistor



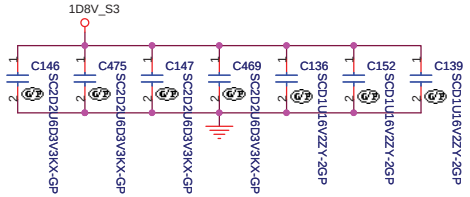
Do not share the Term resistor between the DDR addess and Control Signals.

Decoupling Capacitor

Put decap near power(0.9V) and pull-up resistor

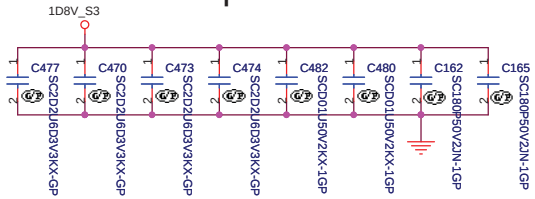


Place these Caps near DM1



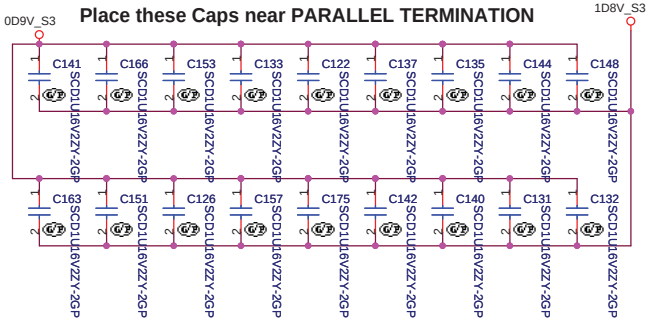
Layout Note:
Place one cap close to every 2 pullup resistors terminated to 0D9V_S3

Place these Caps near DM2



Layout Note:
Place one cap close to every 2 pullup resistors terminated to 0D9V_S3

Place these Caps near PARALLEL TERMINATION



DIS DOCK

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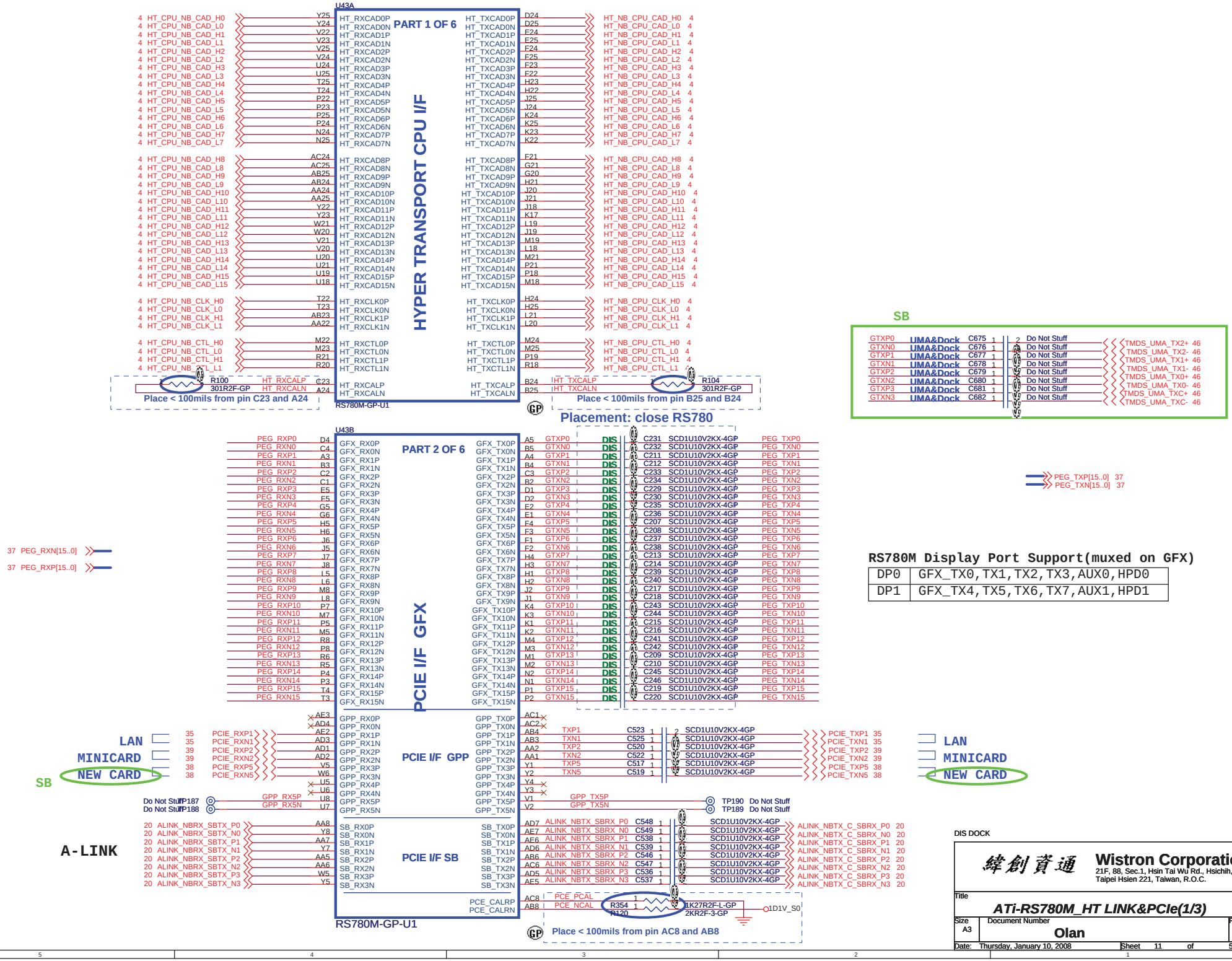
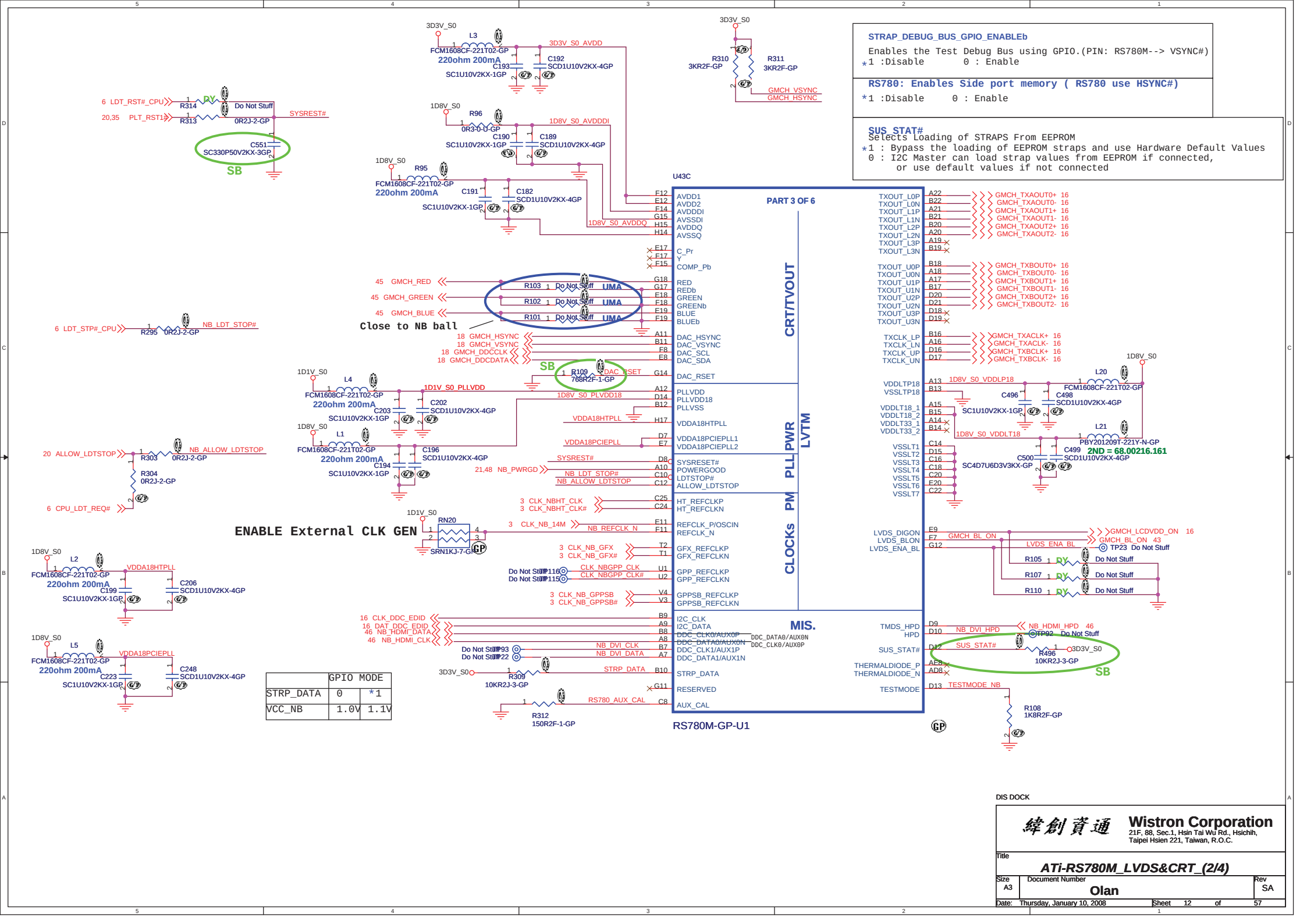
Taipei Hsien 221, Taiwan, R.O.C.

Title: ***DDR_DAMPING & TERMINATION***

Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 10 of 57


U43A
PART 1 OF 6
HYPER TRANSPORT CPU I/F
RS780M-GP-U1
Place < 100mils from pin C23 and A24
Place < 100mils from pin B25 and B24
Placement: close RS780
U43B
PART 2 OF 6
PCIE I/F GFX
PCIE I/F GPP
PCIE I/F SB
RS780M-GP-U1
Place < 100mils from pin AC8 and AB8
SB
LAN
MINICARD
NEW CARD
A-LINK
RS780M Display Port Support(muxed on GFX)
DP0 GFX_TX0,TX1,TX2,TX3,AUX0,HPD0
DP1 GFX_TX4,TX5,TX6,TX7,AUX1,HPD1
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
ATi-RS780M_HT LINK&PCIe(1/3)
Olan
Size A3
Rev SA
Date: Thursday, January 10, 2008
Sheet 11 of 57



DIS DOCK

Wistron Corporation
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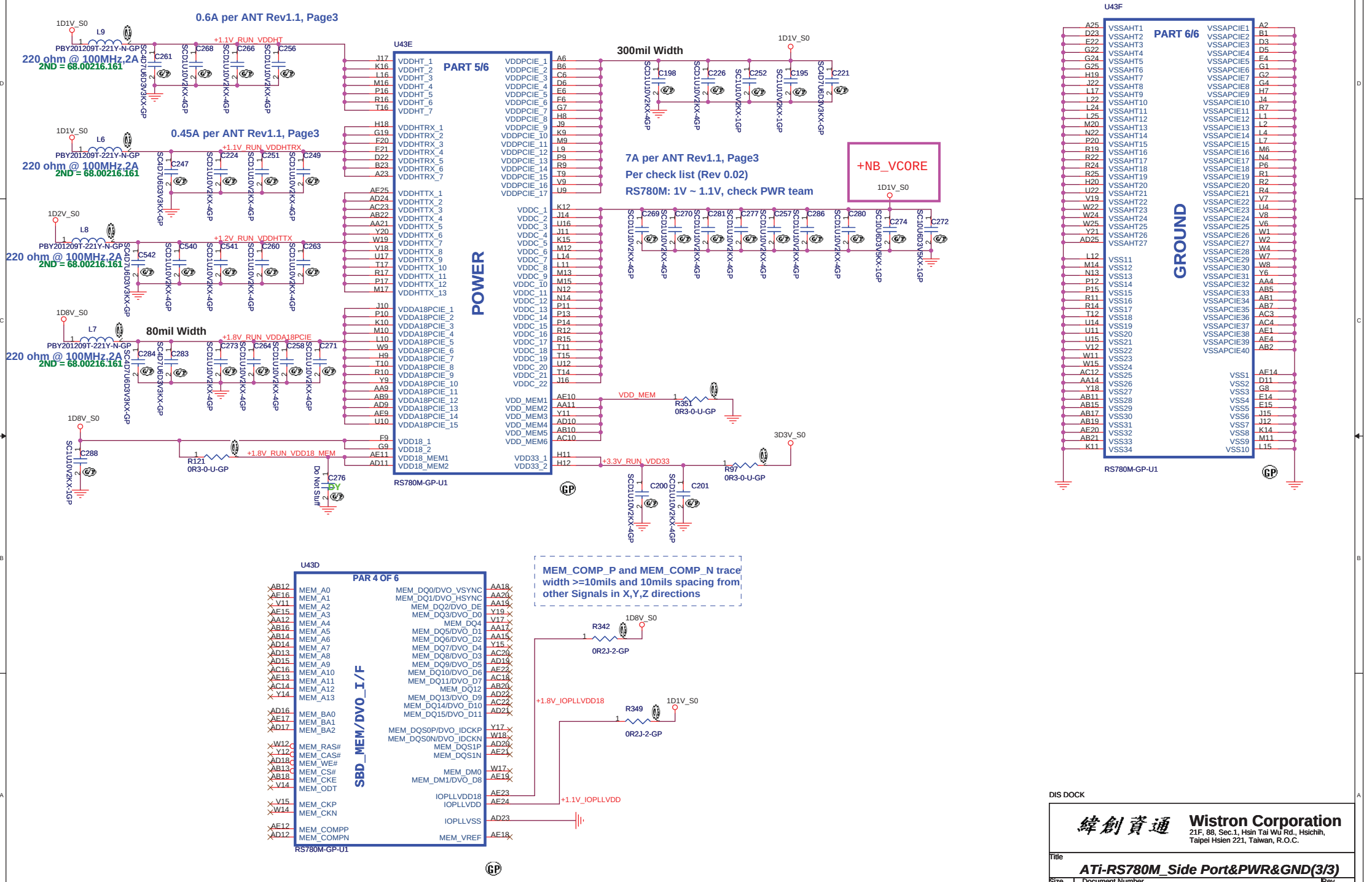
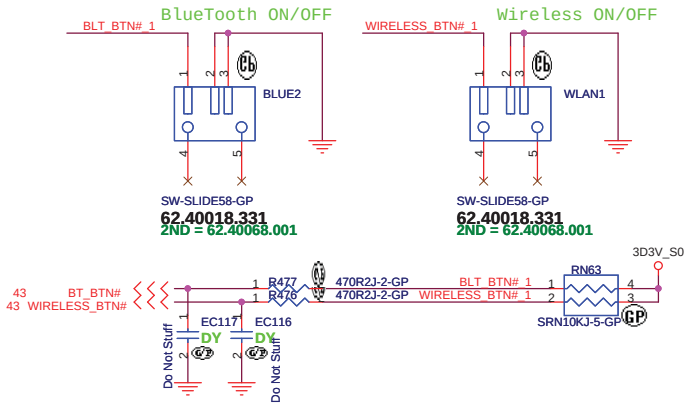
Taipei Hsien 221, Taiwan, R.O.C.

Title: ATi-RS780M_LVDS&CRT_(2/4)

Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 12 of 57


0.6A per ANT Rev1.1, Page3
220 ohm @ 100MHz,2A
2ND = 68.00216.161
0.45A per ANT Rev1.1, Page3
80mil Width
300mil Width
7A per ANT Rev1.1, Page3
Per check list (Rev 0.02)
RS780M: 1V ~ 1.1V, check PWR team
+NB_VCORE
U43E
PART 5/6
POWER
RS780M-GP-U1
U43F
PART 6/6
GROUND
U43D
PAR 4 OF 6
SBD_MEM/DVO_I/F
MEM_COMP_P and MEM_COMP_N trace width >=10mils and 10mils spacing from other Signals in X,Y,Z directions
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
ATi-RS780M_Side Port&PWR&GND(3/3)
Size A3
Document Number Olan
Rev SA
Date: Thursday, January 10, 2008
Sheet 13 of 57



DIS DOCK

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Title: **SWITCH**

Size	Document Number	Rev
A3	Olan	SA

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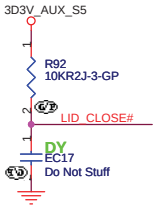
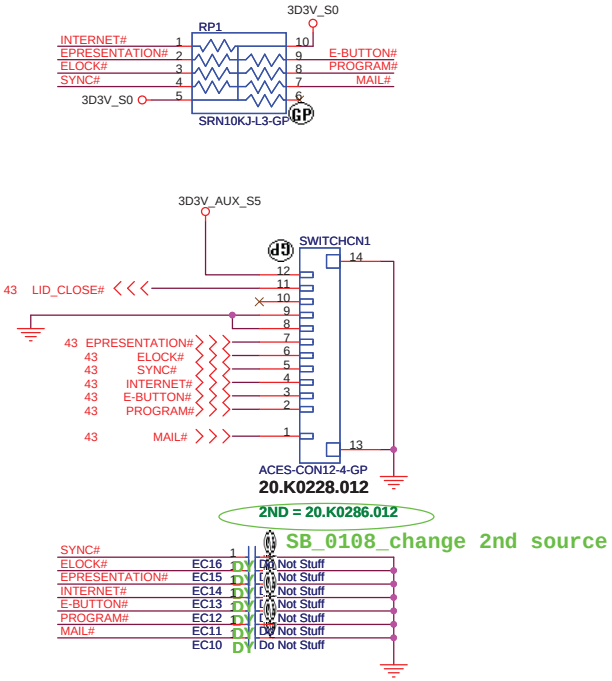
LAUNCH





DIS DOCK

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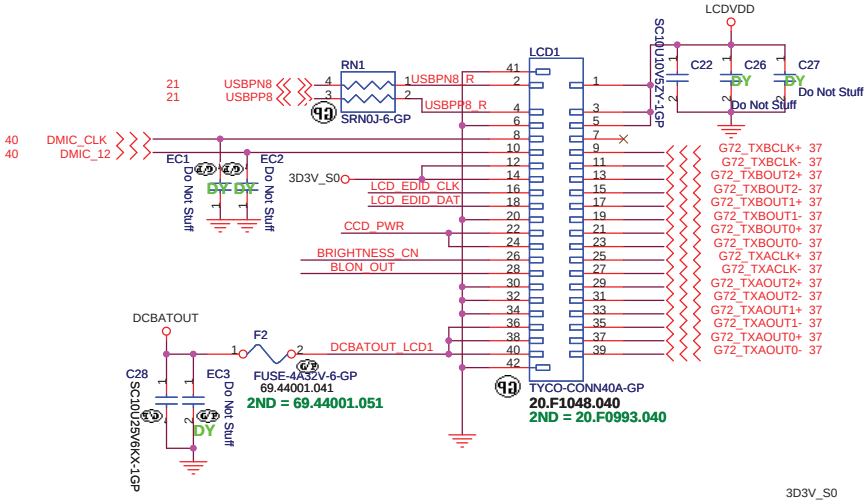
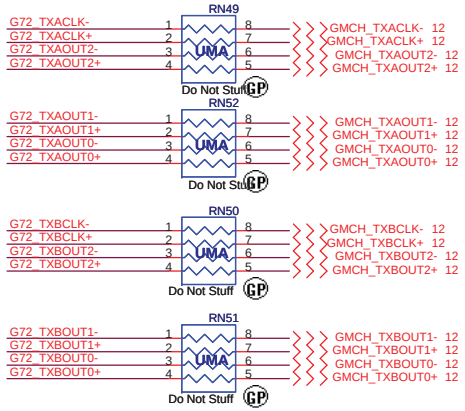
Title: LAUNCH

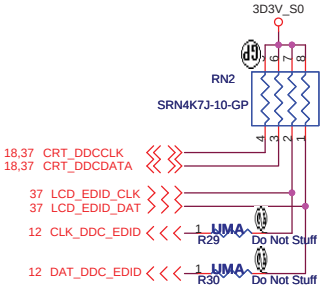
Size	Document Number	Rev
A3	Olan	SA

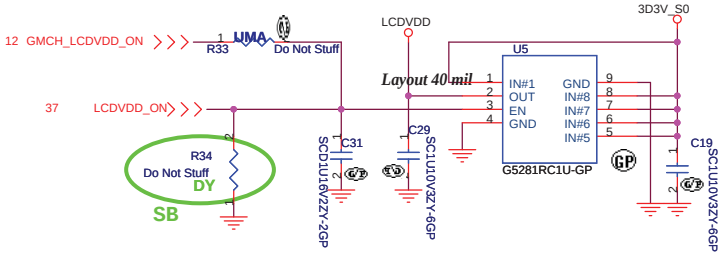
Date: Thursday, January 10, 2008 Sheet 15 of 57

LCD/INVERTER/CCD CONN







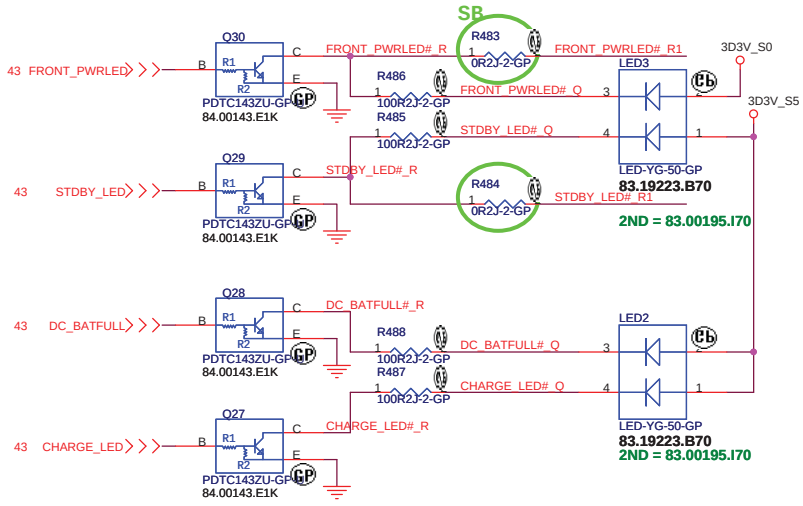


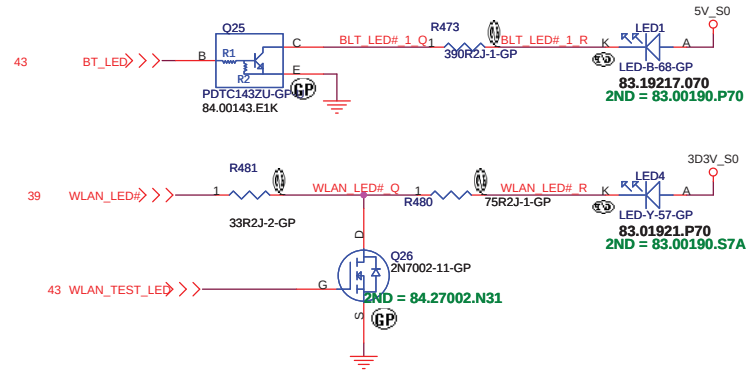
DIS DOCK

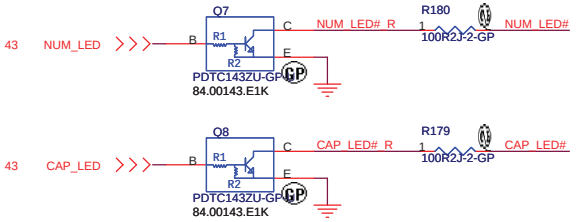
緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

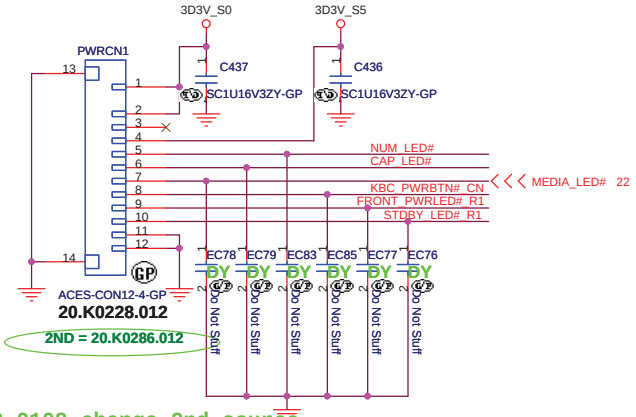
Title	LCD CONN	
Size: A3	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 16 of 57	

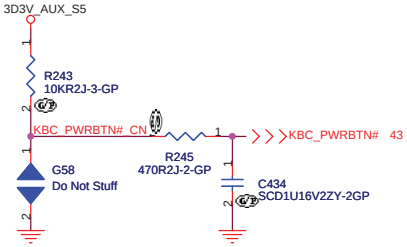
LED





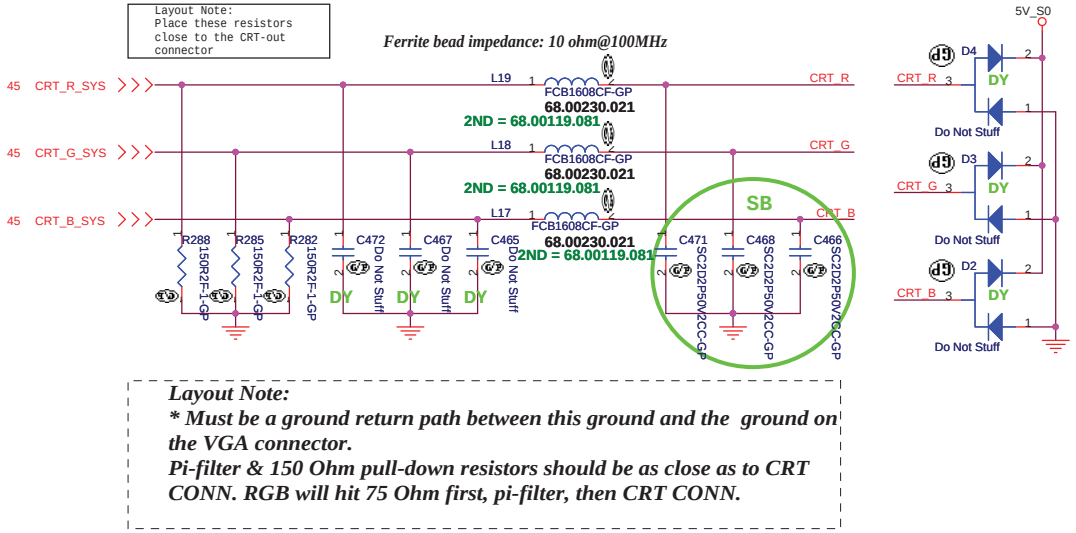




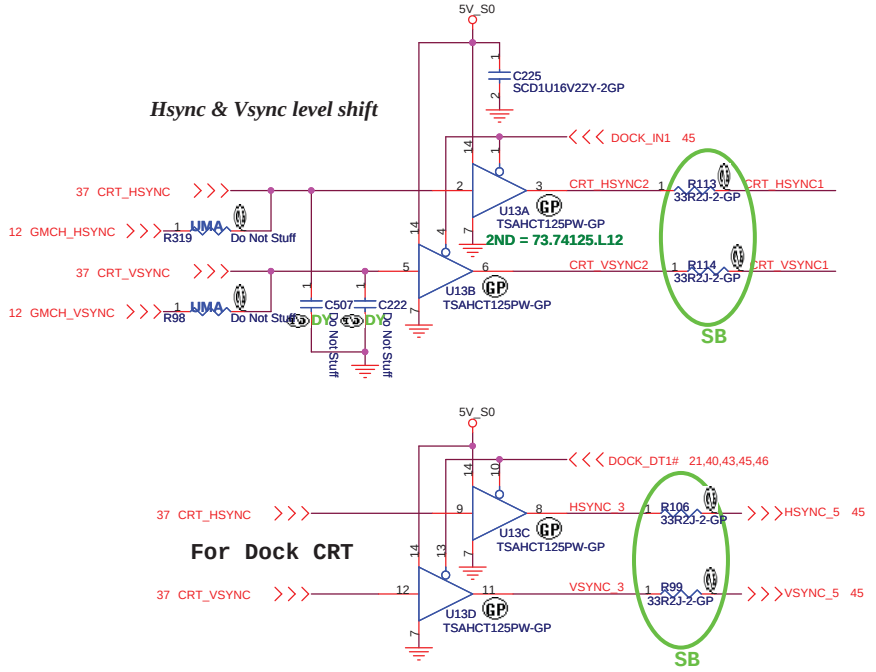


SB_0108_change 2nd source

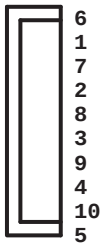
緯創資通 Wistron Corporation		
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.		
Title: LED & LAUNCH		
Size: A3	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 17 of 57	

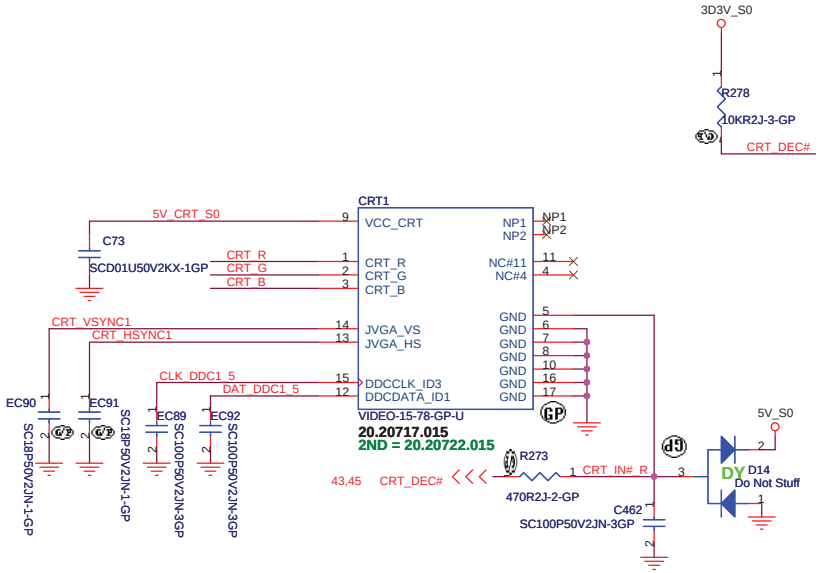


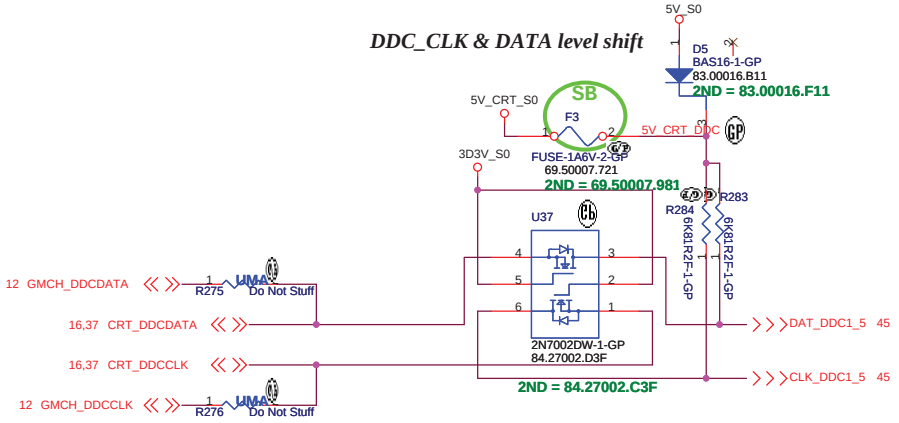
Layout Note:
** Must be a ground return path between this ground and the ground on the VGA connector.*
Pi-filter & 150 Ohm pull-down resistors should be as close as to CRT CONN. RGB will hit 75 Ohm first, pi-filter, then CRT CONN.



CRT I/F & CONNECTOR

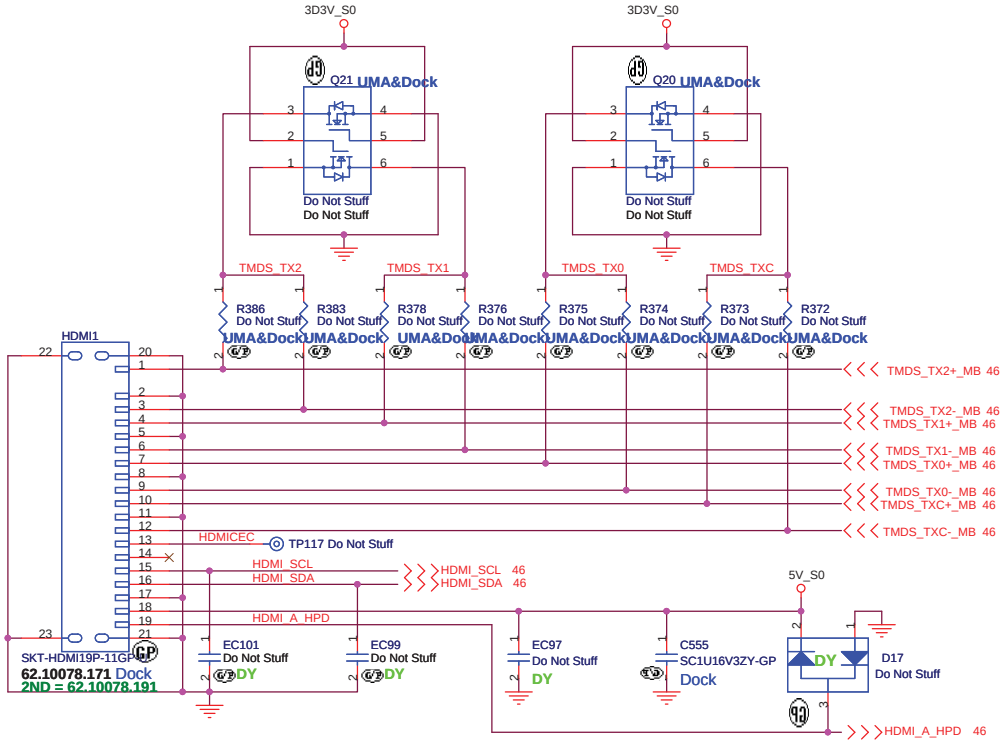






DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	**CRT Connector**	
Size	Document Number **Olan**	Rev SA
Date: Thursday, January 10, 2008	Sheet 18 of 57	



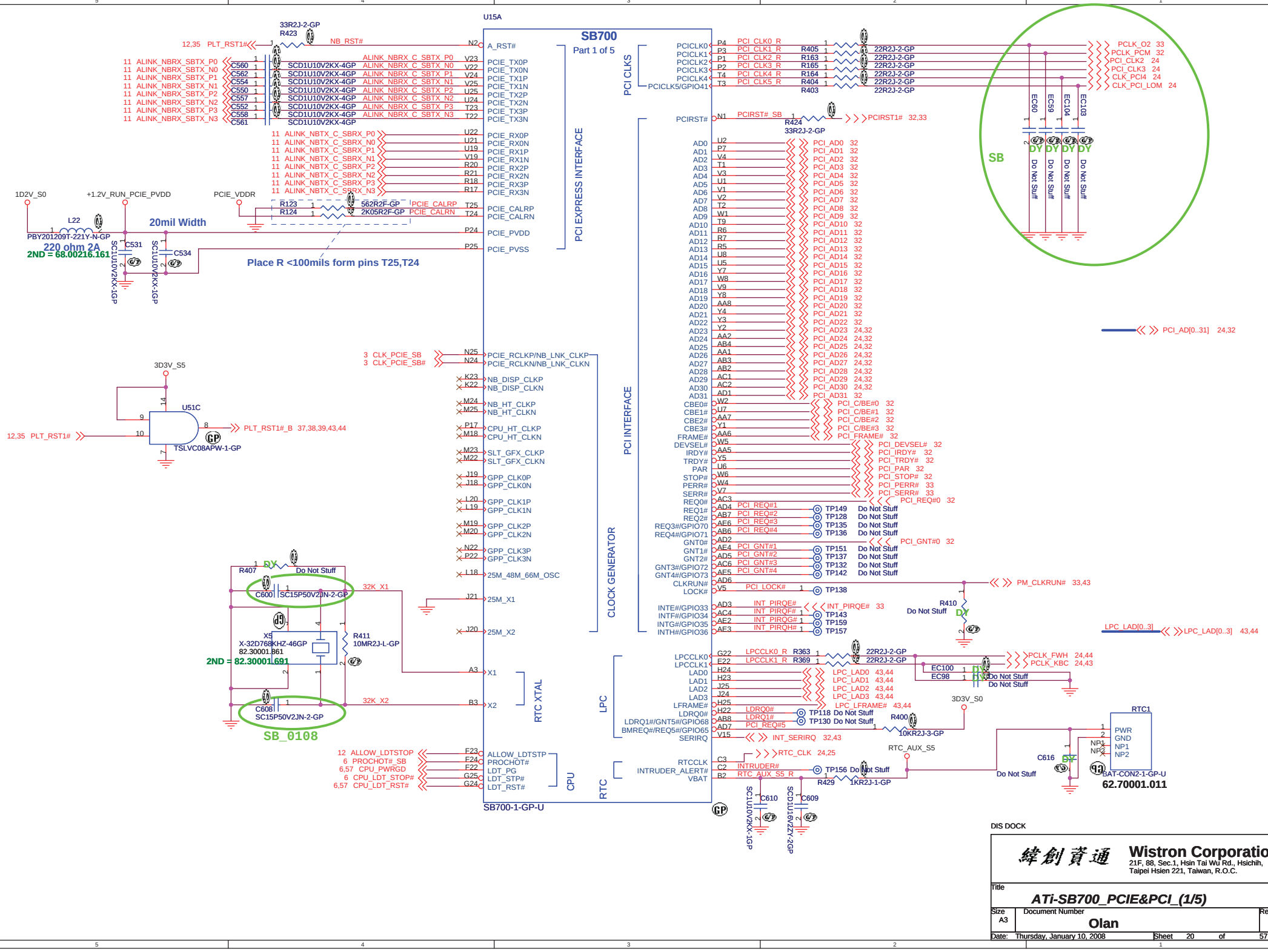
DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: **HDMI CONNECTOR**

Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 19 of 57


U15A
SB700
Part 1 of 5
PCI CLKS
PCI EXPRESS INTERFACE
PCI INTERFACE
CLOCK GENERATOR
LPC
RTC XTAL
CPU
RTC
SB700-1-GP-U
33R2J-2-GP
R423
12,35 PLT_RST1#
NB_RST#
A_RST#
PCIE_TX0P
PCIE_TX0N
PCIE_TX1P
PCIE_TX1N
PCIE_TX2P
PCIE_TX2N
PCIE_TX3P
PCIE_TX3N
PCIE_RX0P
PCIE_RX0N
PCIE_RX1P
PCIE_RX1N
PCIE_RX2P
PCIE_RX2N
PCIE_RX3P
PCIE_RX3N
PCIE_CALRP
PCIE_CALRN
PCIE_PVDD
PCIE_PVSS
1D2V_S0
+1.2V_RUN_PCIE_PVDD
PCIE_VDDR
L22
PBY201209T-221Y-N-GP
220 ohm 2A
2ND = 68.00216.161
20mil Width
C531
C534
SC1U10V2KX-1GP
562R2F-GP
2K05R2F-GP
Place R <100mils form pins T25,T24
3D3V_S5
U51C
TSLVC08APW-1-GP
PLT_RST1#_B 37,38,39,43,44
3 CLK_PCIE_SB
3 CLK_PCIE_SB#
PCIE_RCLKP/NB_LNK_CLKP
PCIE_RCLKN/NB_LNK_CLKN
NB_DISP_CLKP
NB_DISP_CLKN
NB_HT_CLKP
NB_HT_CLKN
CPU_HT_CLKP
CPU_HT_CLKN
SLT_GFX_CLKP
SLT_GFX_CLKN
GPP_CLK0P
GPP_CLK0N
GPP_CLK1P
GPP_CLK1N
GPP_CLK2P
GPP_CLK2N
GPP_CLK3P
GPP_CLK3N
25M_48M_66M_OSC
25M_X1
25M_X2
R407
DY
Do Not Stuff
C600
SC15P50V2JN-2-GP
32K_X1
X5
X-32D768KHZ-46GP
82.30001.861
2ND = 82.30001.691
R411
10MR2J-L-GP
C608
SC15P50V2JN-2-GP
32K_X2
SB_0108
ALLOW_LDTSTP
PROCHOT#
LDT_PG
LDT_STP#
LDT_RST#
12 ALLOW_LDTSTOP
6 PROCHOT#_SB
6,57 CPU_PWRGD
6 CPU_LDT_STOP#
6,57 CPU_LDT_RST#
PCICLK0
PCICLK1
PCICLK2
PCICLK3
PCICLK4
PCICLK5/GPIO41
PCI_CLK0_R
PCI_CLK1_R
PCI_CLK2_R
PCI_CLK3_R
PCI_CLK4_R
PCI_CLK5_R
R405
R163
R165
R164
R404
R403
22R2J-2-GP
PCLK_O2 33
PCLK_PCM 32
PCI_CLK2 24
PCI_CLK3 24
CLK_PCI4 24
CLK_PCI_LOM 24
EC60
EC59
EC104
EC103
SB
DY
Do Not Stuff
PCIRST#
PCIRST#_SB
R424
33R2J-2-GP
PCIRST1# 32,33
PCI_AD0 32
PCI_AD1 32
PCI_AD2 32
PCI_AD3 32
PCI_AD4 32
PCI_AD5 32
PCI_AD6 32
PCI_AD7 32
PCI_AD8 32
PCI_AD9 32
PCI_AD10 32
PCI_AD11 32
PCI_AD12 32
PCI_AD13 32
PCI_AD14 32
PCI_AD15 32
PCI_AD16 32
PCI_AD17 32
PCI_AD18 32
PCI_AD19 32
PCI_AD20 32
PCI_AD21 32
PCI_AD22 32
PCI_AD23 24,32
PCI_AD24 24,32
PCI_AD25 24,32
PCI_AD26 24,32
PCI_AD27 24,32
PCI_AD28 24,32
PCI_AD29 24,32
PCI_AD30 24,32
PCI_AD31 32
PCI_AD[0..31] 24,32
PCI_C/BE#0 32
PCI_C/BE#1 32
PCI_C/BE#2 32
PCI_C/BE#3 32
PCI_FRAME# 32
PCI_DEVSEL# 32
PCI_IRDY# 32
PCI_TRDY# 32
PCI_PAR 32
PCI_STOP# 32
PCI_PERR# 33
PCI_SERR# 33
PCI_REQ#0 32
PCI_GNT#0 32
PCI_REQ#1
PCI_REQ#2
PCI_REQ#3
PCI_REQ#4
PCI_GNT#1
PCI_GNT#2
PCI_GNT#3
PCI_GNT#4
TP149 Do Not Stuff
TP128 Do Not Stuff
TP135 Do Not Stuff
TP136 Do Not Stuff
TP151 Do Not Stuff
TP137 Do Not Stuff
TP132 Do Not Stuff
TP142 Do Not Stuff
PCI_LOCK#
TP138
PM_CLKRUN# 33,43
R410
Do Not Stuff
DY
INT_PIRQE#
INT_PIRQF#
INT_PIRQG#
INT_PIRQH#
INT_PIRQE# 33
TP143
TP159
TP157
LPC_LAD[0..3]
LPC_LAD[0..3] 43,44
LPCCLK0_R
LPCCLK1_R
R363
R369
LPCCLK0
LPCCLK1
LAD0
LAD1
LAD2
LAD3
LFRAME#
LDRQ0#
LDRQ1#
PCI_REQ#5
SERIRQ
LPC_LAD0 43,44
LPC_LAD1 43,44
LPC_LAD2 43,44
LPC_LAD3 43,44
LPC_LFRAME# 43,44
PCLK_FWH 24,44
PCLK_KBC 24,43
EC100
EC98
TP118 Do Not Stuff
TP130 Do Not Stuff
R400
10KR2J-3-GP
3D3V_S0
INT_SERIRQ 32,43
RTC_CLK 24,25
RTCCLK
INTRUDER_ALERT#
VBAT
INTRUDER#
RTC_AUX_S5_R
TP156 Do Not Stuff
R429
1KR2J-1-GP
RTC_AUX_S5
RTC1
PWR
GND
NP1
NP2
C616
BAT-CON2-1-GP-U
62.70001.011
C610
C609
SC1U10V2KX-1GP
SCD1U16V2ZY-2GP
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
ATi-SB700_PCIE&PCI_(1/5)
Size
A3
Document Number
Olan
Rev
SA
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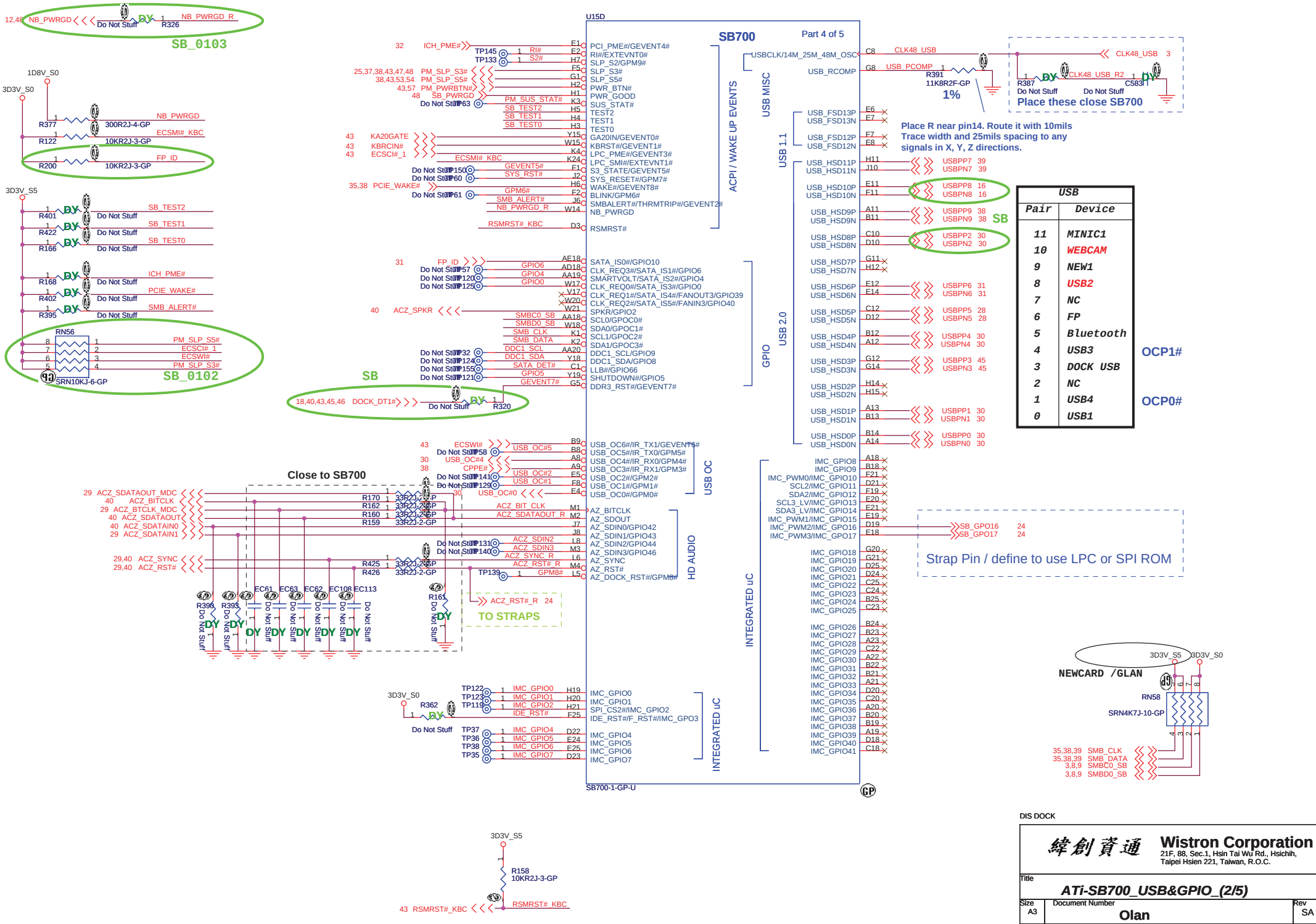
SB_0103
SB_0102
SB700
Part 4 of 5
U15D
SB700-1-GP-U
Close to SB700
TO STRAPS
Place these close SB700
Place R near pin14. Route it with 10mils Trace width and 25mils spacing to any signals in X, Y, Z directions.
Strap Pin / define to use LPC or SPI ROM
USB
Pair Device
11 MINIC1
10 WEBCAM
9 NEW1
8 USB2
7 NC
6 FP
5 Bluetooth
4 USB3
3 DOCK USB
2 NC
1 USB4
0 USB1
OCP1#
OCP0#
NEWCARD /GLAN
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
ATi-SB700_USB&GPIO_(2/5)
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PLACE SATA AC DECOUPLING
CAPS CLOSE TO SB700

SATA HDD
SATA ODD
E-SATA
SB

SB700
Part 2 of 5
U15B
SB700-1-GP-U

SERIAL ATA
ATA 66/100/133
SPI ROM
SATA PWR
HW MONITOR

SB_0108
Very Close to SB700
Close to SB700
Close to SB700

SB_0103

PlanarID
(2,1,0)
SA: 0,0,0
SB: 0,0,1
SC: 0,1,0
-1: 0,1,1

CLK_ID
(1,0)
ICS: 0,0
SEG: 0,1
RTM: 1,0

Layout connect to Cap then GND

DIS DOCK

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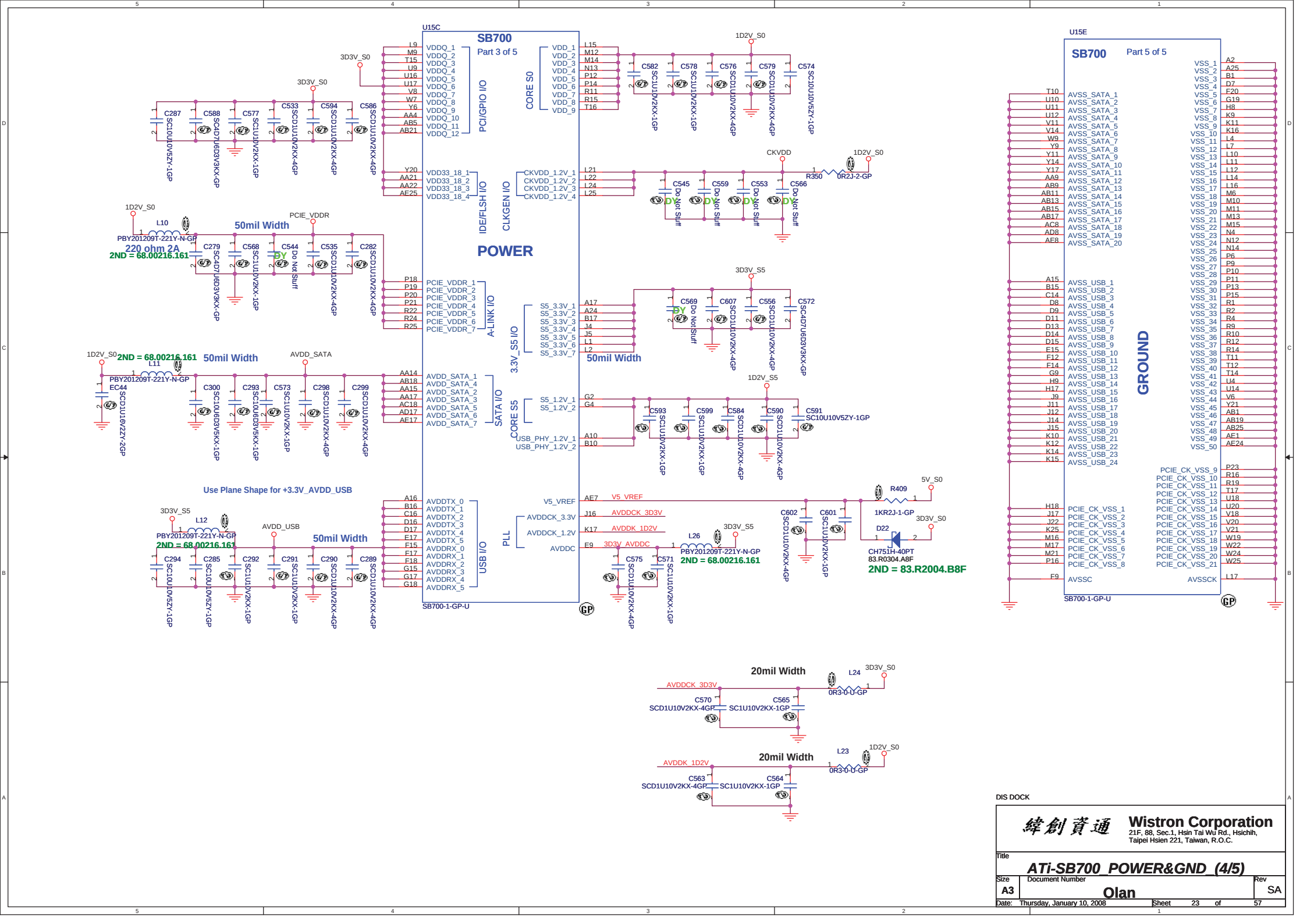
Title: ATi-SB700_SATA-IDE_(3/5)
Size: A3
Document Number: Olan
Rev: SA
Date: Thursday, January 10, 2008
Sheet 22 of 57


U15C
SB700
Part 3 of 5
POWER
50mil Width
2ND = 68.00216.161
220 ohm 2A
Use Plane Shape for +3.3V_AVDD_USB
20mil Width
U15E
SB700
Part 5 of 5
GROUND
SB700-1-GP-U
2ND = 83.R2004.B8F
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
ATi-SB700_POWER&GND_(4/5)
Size
A3
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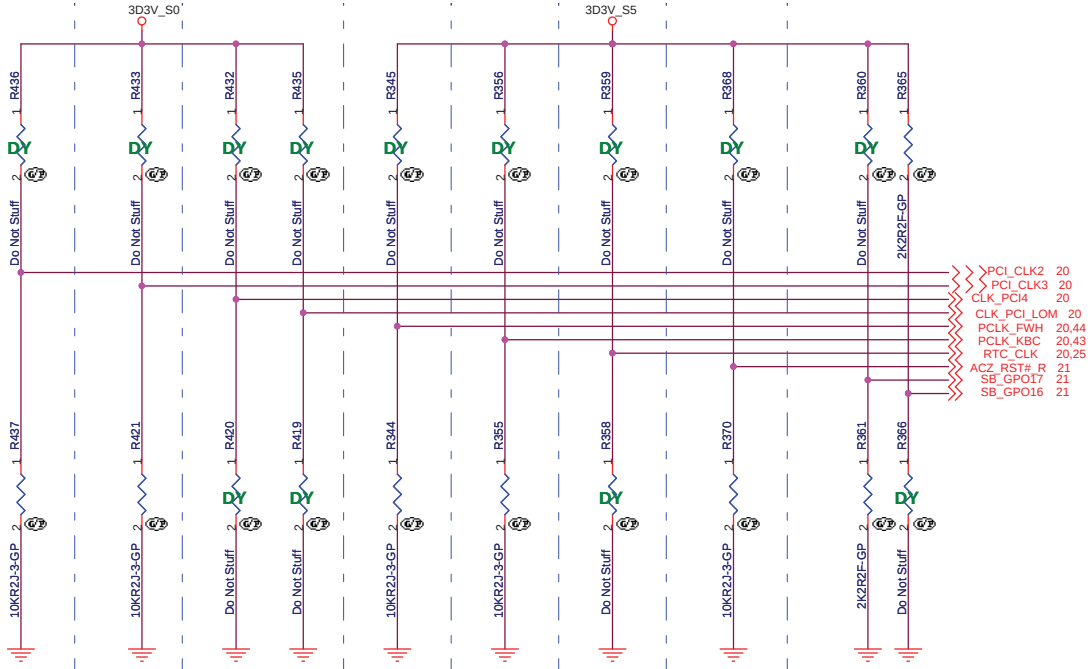
REQUIRED STRAPS

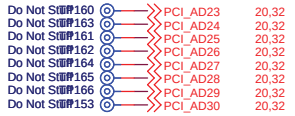
REQUIRED SYSTEM STRAPS



	PCI_CLK2	PCI_CLK3	CLK_PCI_LOM CLK_PCI4	PCLK_FWH	PCLK_KBC	RTCCLK	AZ_RST#	SB_GPO17 , SB_GPO16
PULL HIGH	WatchDOG (NB_PWRGD) ENABLED	USE DEBUG STRAPS	RESERVED	IMC ENABLED	CLKGEN ENABLED (Use Internal)	INTERNAL RTC DEFAULT	ENABLE PCI ROM BOOT	ROM TYPE: H, H = Reserved H, L = SPI ROM DEFAULT
PULL LOW	WatchDog (NB_PWRGD) DISABLED DEFAULT	IGNORE DEBUG STRAPS DEFAULT		IMC DISABLED DEFAULT	CLKGEN DISABLED (Use External) DEFAULT	EXT. RTC (PD on X1, apply 32KHz to RTC_CLK)	DISABLE PCI ROM BOOT DEFAULT	L, H = LPC ROM L, L = FWH ROM

NOTE: SB700 HAS INTERNAL 15K PULL UP RESISTOR FOR RTCCLK

DEBUG STRAPS



	PCI_AD28	PCI_AD27	PCI_AD26	PCI_AD25	PCI_AD24	PCI_AD23	PCI_AD30 PCI_AD29
PULL HIGH	USE LONG RESET (DEFAULT)	USE PCI PLL (DEFAULT)	USE ACPI BCLK (DEFAULT)	USE IDE PLL (DEFAULT)	USE DEFAULT PCIE STRAPS (DEFAULT)	Reserved (DEFAULT)	Reserved
PULL LOW	USE SHORT RESET	BYPASS PCI PLL	BYPASS ACPI BCLK	BYPASS IDE PLL	USE EEPROM PCIE STRAPS	Reserved	

Note: SB700 has 15K internal PU FOR PCI_AD[30:23]

DIS DOCK

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Taipei Hsien 221, Taiwan, R.O.C.

Title: ATi-SB700_STRAPPING_(5/5)

Size: A3 | Document Number: Olan | Rev: SA

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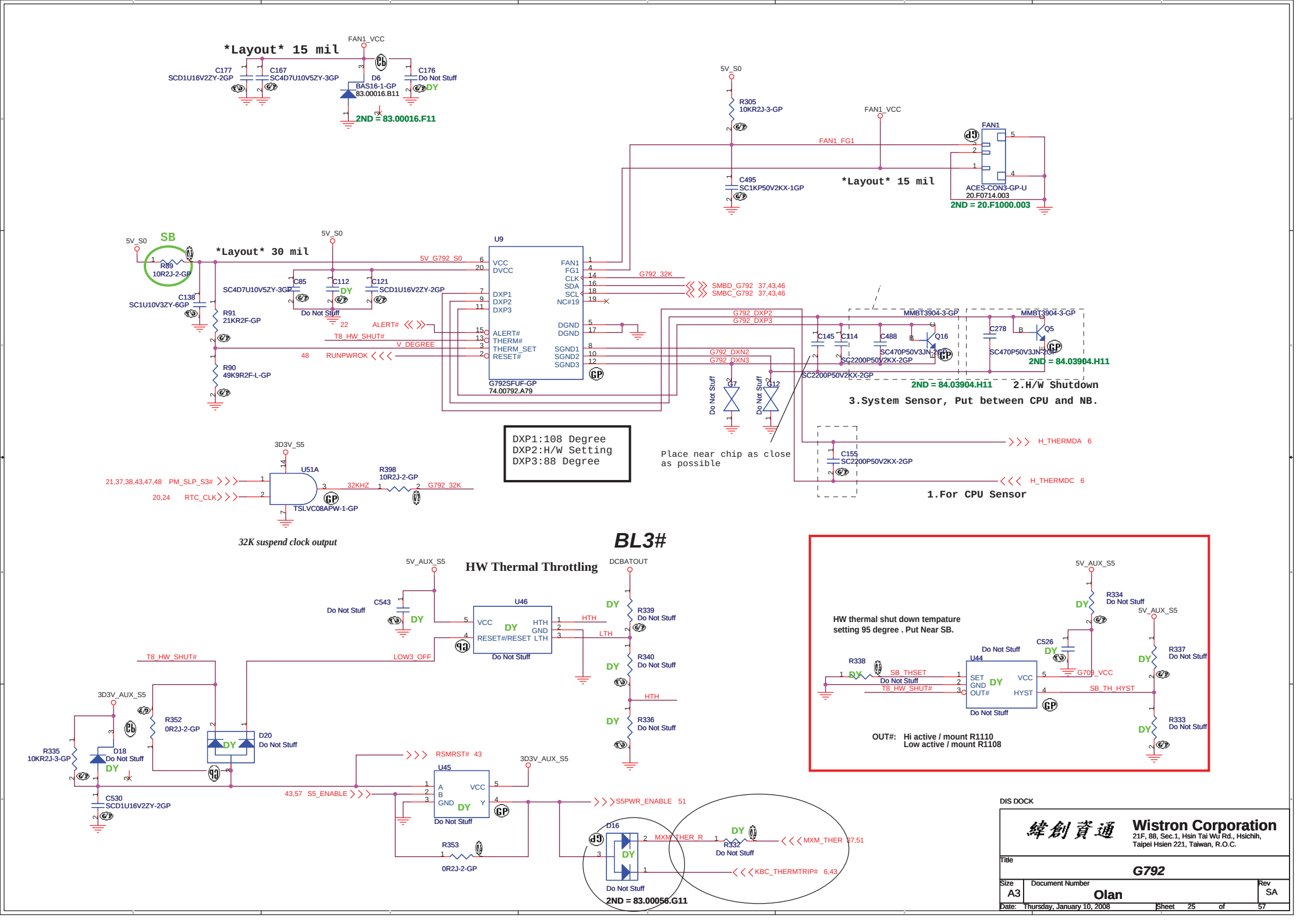
Layout 15 mil
FAN1_VCC
C177 SCD1U16V2ZY-2GP
C167 SC4D7U10V5ZY-3GP
D6 BAS16-1-GP 83.00016.B11
C176 Do Not Stuff
2ND = 83.00016.F11
5V_S0
R305 10KR2J-3-GP
FAN1_FG1
C495 SC1KP50V2KX-1GP
Layout 15 mil
FAN1
ACES-CON3-GP-U 20.F0714.003
2ND = 20.F1000.003
SB
Layout 30 mil
R89 10R2J-2-GP
C138 SC1U10V3ZY-6GP
R91 21KR2F-GP
R90 49K9R2F-L-GP
C85 SC4D7U10V5ZY-3GP
C112 DY
C121 SCD1U16V2ZY-2GP
Do Not Stuff
5V_G792_S0
U9
VCC
DVCC
DXP1
DXP2
DXP3
ALERT#
THERM#
THERM_SET
RESET#
DGND
SGND1
SGND2
SGND3
FAN1
FG1
CLK
SDA
SCL
NC#19
G792SFUF-GP 74.00792.A79
G792_32K
SMBD_G792 37,43,46
SMBC_G792 37,43,46
ALERT#
T8_HW_SHUT#
V_DEGREE
RUNPWROK
G792_DXP2
G792_DXP3
G792_DXN2
G792_DXN3
MMBT3904-3-GP
Q16
Q5
C145
C114
C488
C278
SC470P50V3JN-2GP
SC2200P50V2KX-2GP
G7
G12
2ND = 84.03904.H11
2.H/W Shutdown
3.System Sensor, Put between CPU and NB.
DXP1:108 Degree
DXP2:H/W Setting
DXP3:88 Degree
Place near chip as close as possible
C155 SC2200P50V2KX-2GP
H_THERMDA 6
H_THERMDC 6
1.For CPU Sensor
3D3V_S5
U51A
TSLVC08APW-1-GP
R398 10R2J-2-GP
21,37,38,43,47,48 PM_SLP_S3#
20,24 RTC_CLK
32KHZ
G792_32K
32K suspend clock output
BL3#
HW Thermal Throttling
5V_AUX_S5
DCBATOUT
C543 Do Not Stuff
U46
VCC
RESET#/RESET
HTH
GND
LTH
R339 Do Not Stuff
R340 Do Not Stuff
R336 Do Not Stuff
T8_HW_SHUT#
LOW3_OFF
3D3V_AUX_S5
R352 0R2J-2-GP
D20 Do Not Stuff
R335 10KR2J-3-GP
D18 Do Not Stuff
C530 SCD1U16V2ZY-2GP
RSMRST# 43
43,57 S5_ENABLE
U45
A
B
GND
Y
R353 0R2J-2-GP
S5PWR_ENABLE 51
D16
MXM_THER_R
R332 Do Not Stuff
MXM_THER 37,51
KBC_THERMTRIP# 6,43
2ND = 83.00056.G11
HW thermal shut down tempature setting 95 degree . Put Near SB.
R338
SB_THSET
U44
SET
OUT#
HYST
C526
G709_VCC
SB_TH_HYST
R334 Do Not Stuff
R337 Do Not Stuff
R333 Do Not Stuff
OUT#: Hi active / mount R1110
Low active / mount R1108
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
G792
Size A3
Document Number Olan
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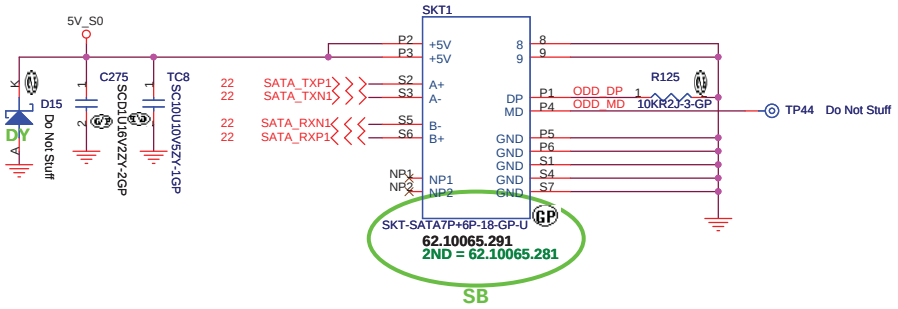
ODD Connector



DIS DOCK

緯創資通 Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.		
Title: CDROM		
Size	Document Number: Olan	Rev: SA
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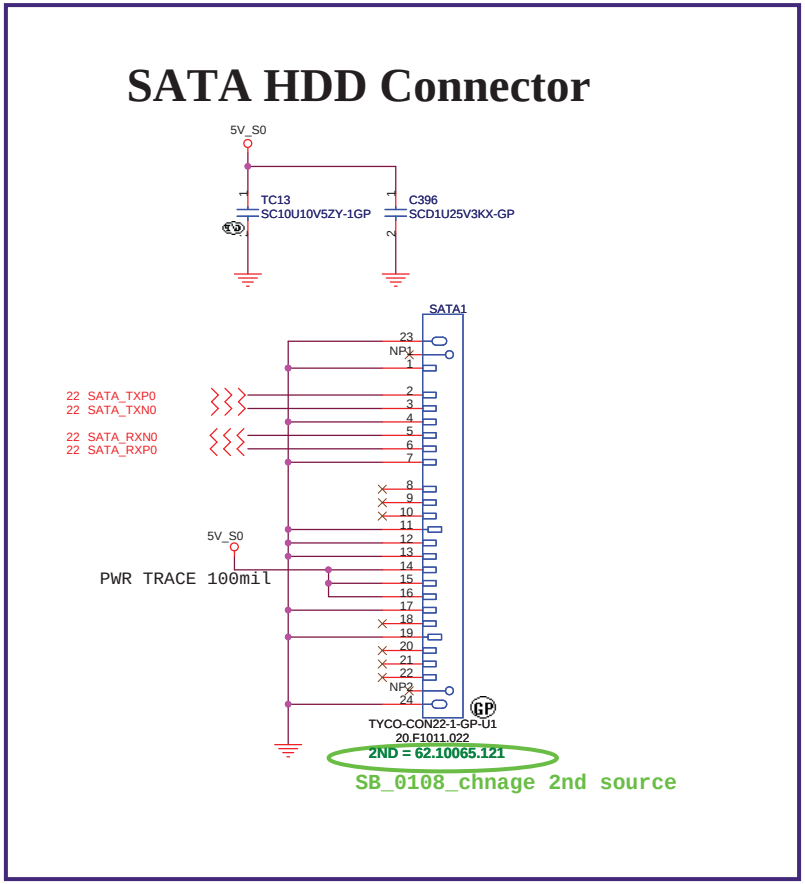
SATA HDD Connector



DIS DOCK

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: HDD

Size | Document Number: Olan | Rev: SA

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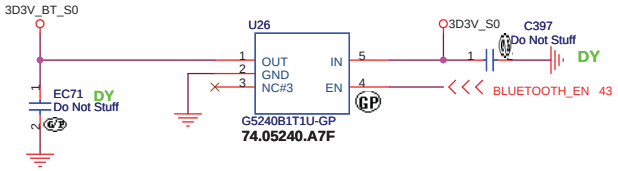
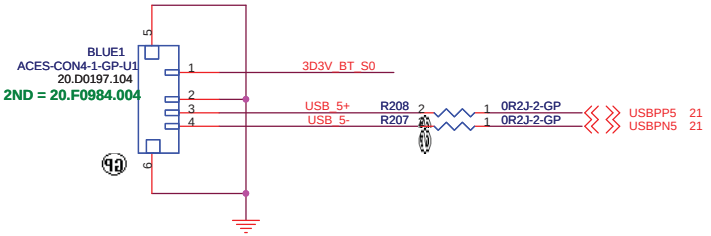
BLUETOOTH MODULE



EC40 put near BLUE1 / all USB put one choke near connector by EMI request



DIS DOCK

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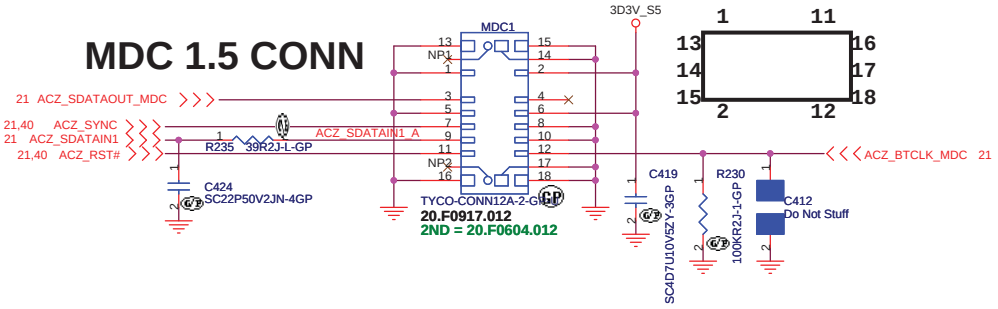
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title		
BLUETOOTH		
Size	Document Number	Rev
	Olan	SA
Date: Thursday, January 10, 2008	Sheet 28 of 57	

MDC 1.5 CONN



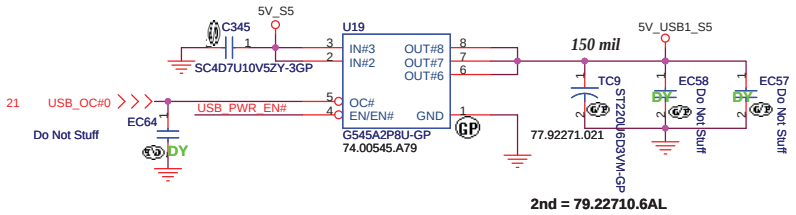
DIS DOCK

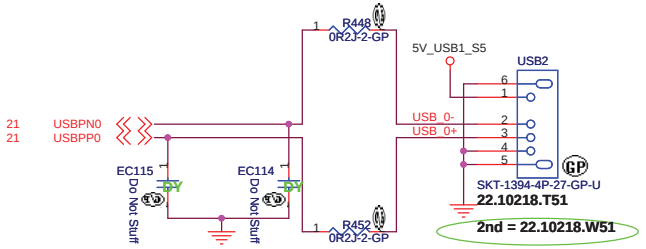
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: MDC

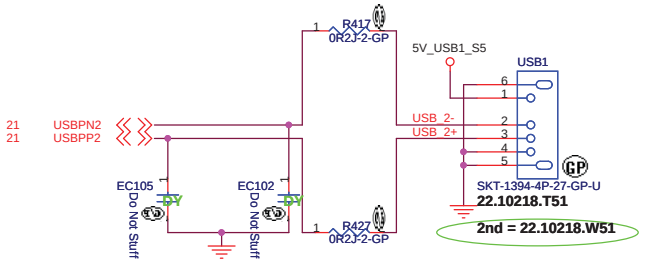
Size | Document Number: Olan | Rev: SA

Date: Thursday, January 10, 2008 | Sheet 29 of 57

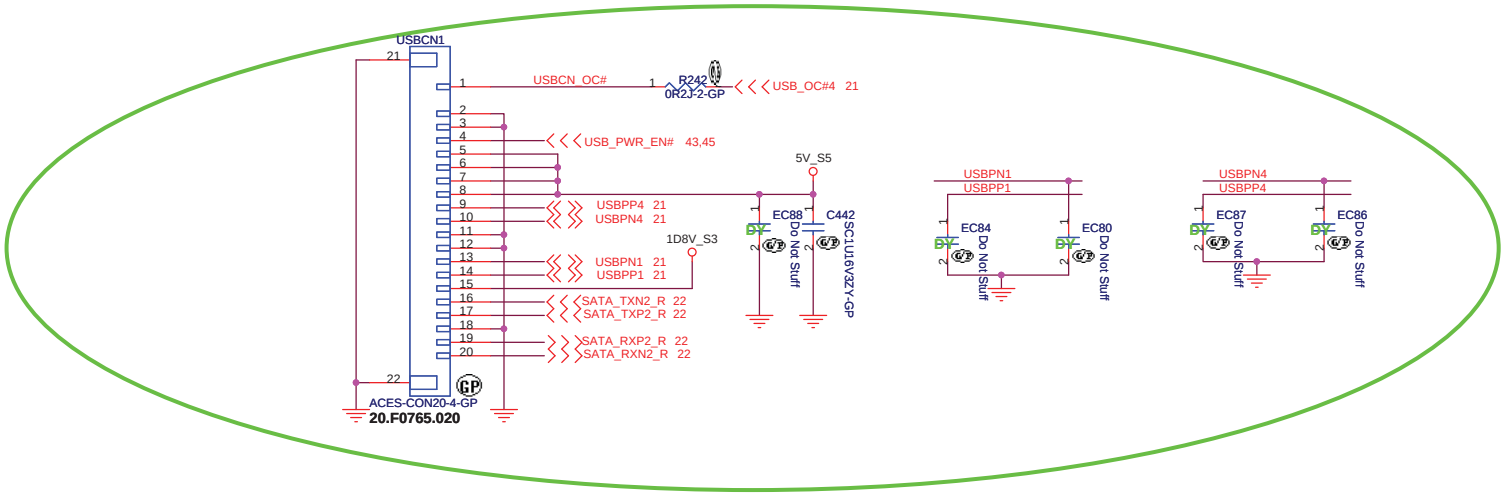




SB_0108_change 2nd source



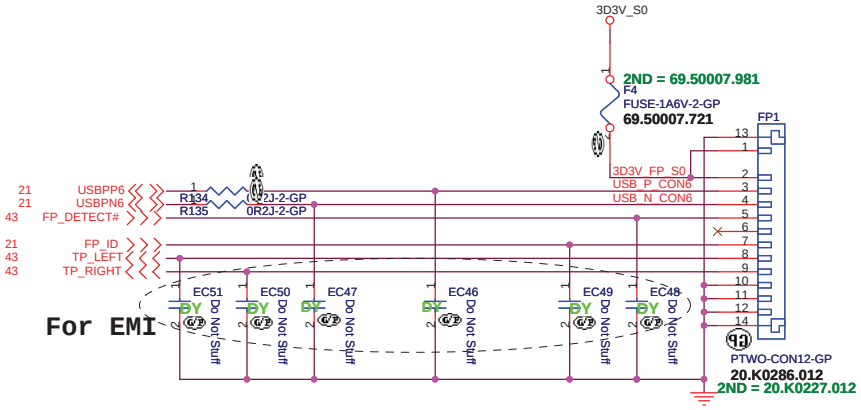
SB_0102

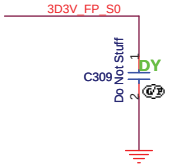


DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title: ***USB***		
Size	Document Number: **Olan**	Rev: SB
Date: Thursday, January 10, 2008	Sheet 30 of 57	

Finger printer





For EMI

DIS DOCK

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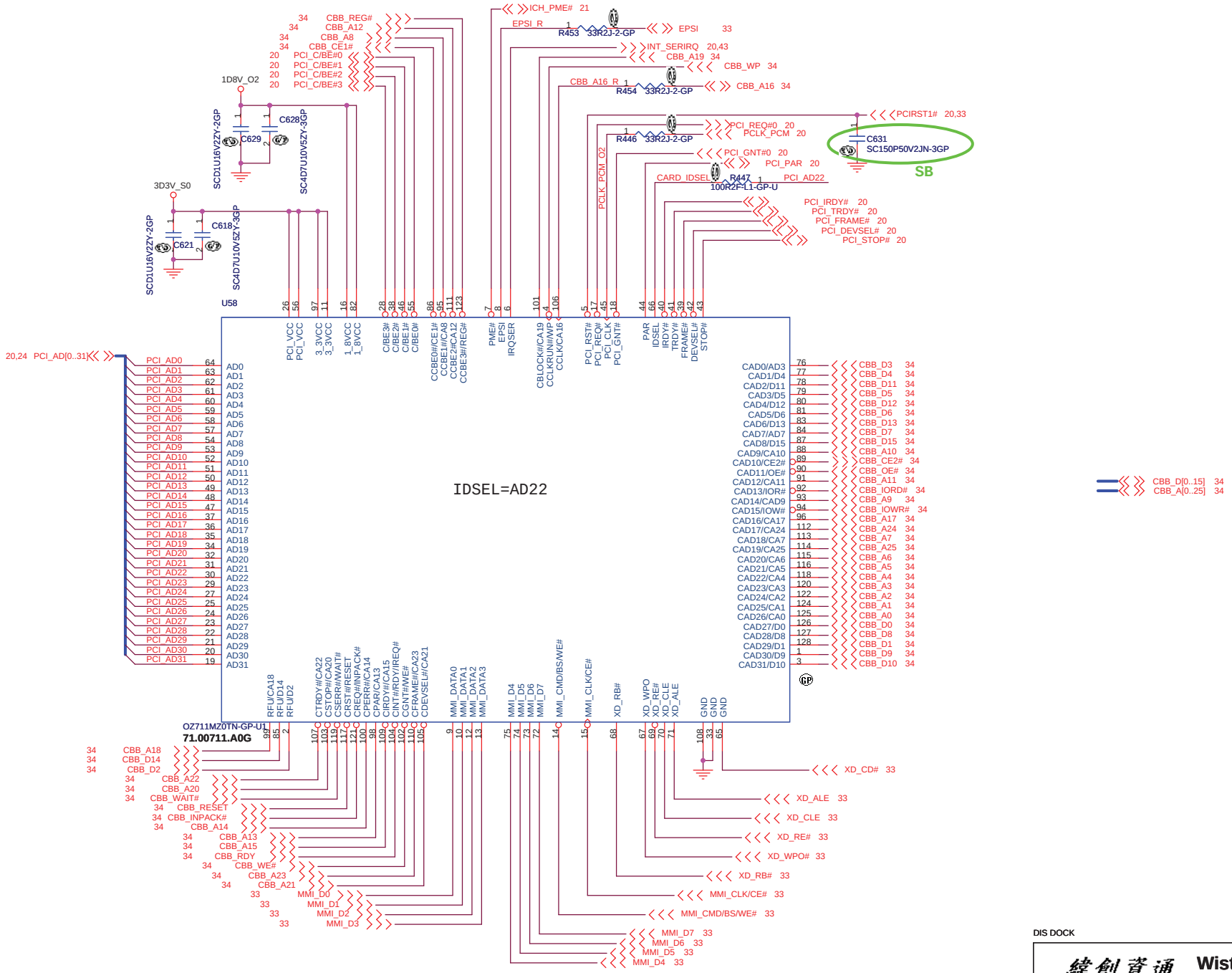
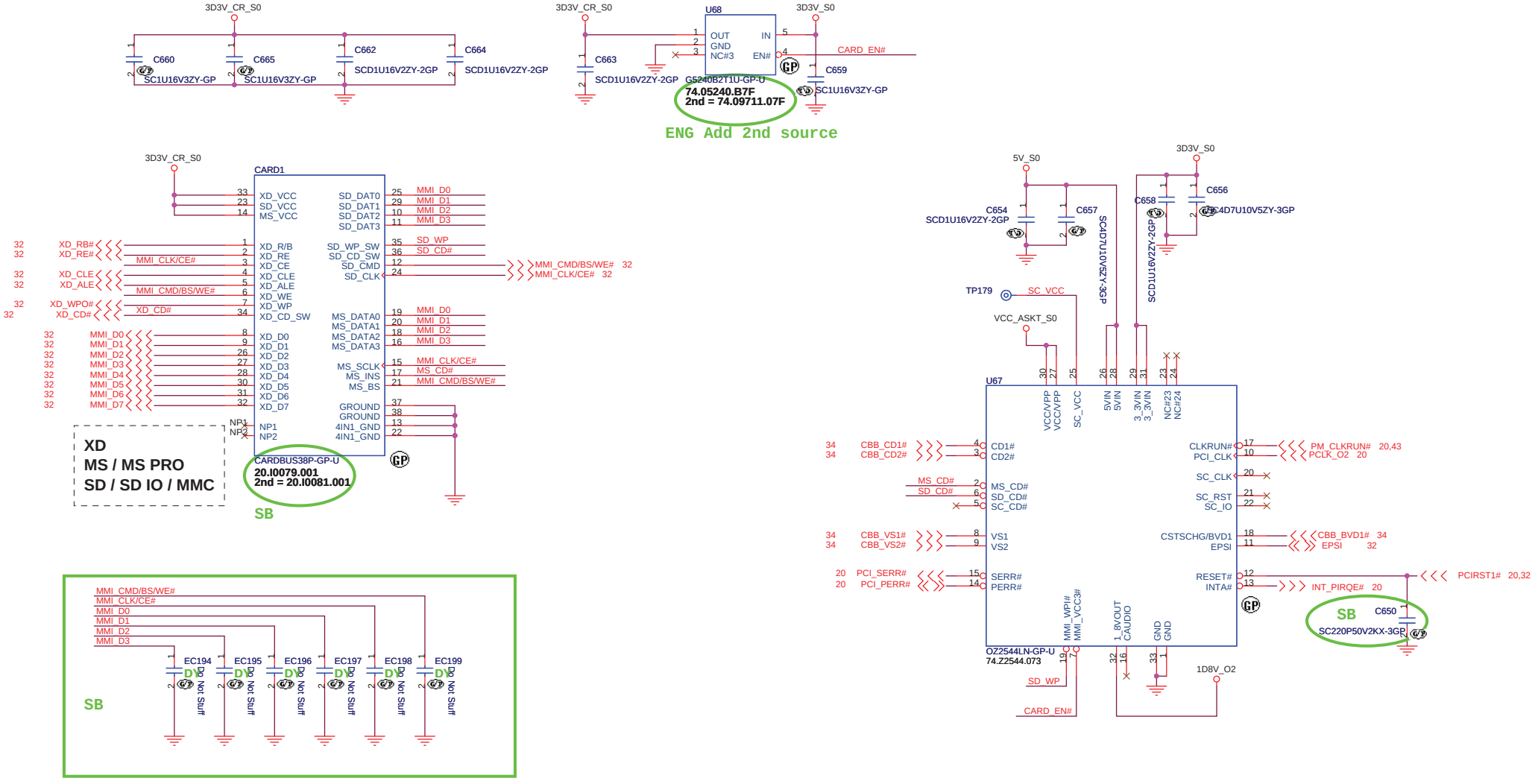
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: *Finger Printer*		
Size	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 31 of 57	



DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	*OZ711MZ0*	
Size: A3	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 32 of 57	



DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: *Card Reader Connector*

Size	Document Number	Rev
A3	Olan	SA

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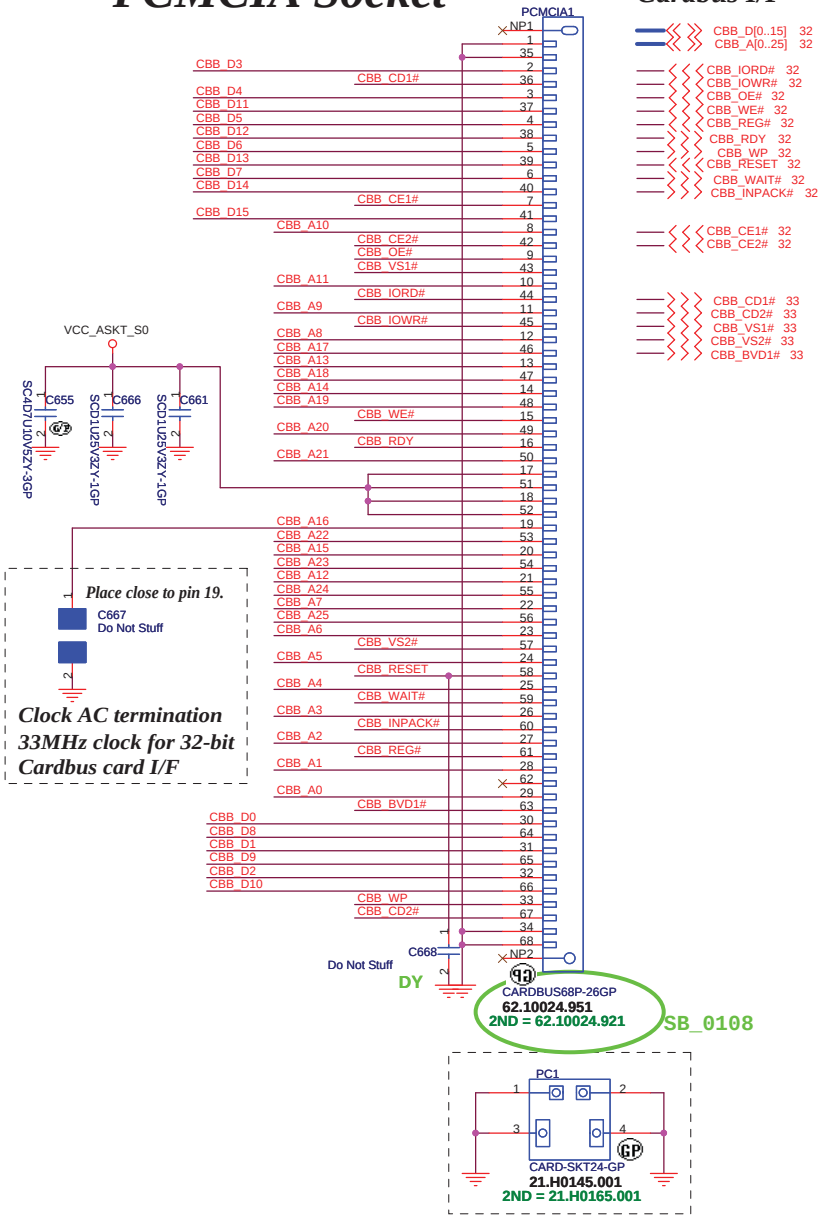
PCMCIA Socket



Cardbus I/F

CBB_D[0..15] 32
CBB_A[0..25] 32
CBB_IORD# 32
CBB_IOWR# 32
CBB_OE# 32
CBB_WE# 32
CBB_REG# 32
CBB_RDY 32
CBB_WP 32
CBB_RESET 32
CBB_WAIT# 32
CBB_INPACK# 32
CBB_CE1# 32
CBB_CE2# 32
CBB_CD1# 33
CBB_CD2# 33
CBB_VS1# 33
CBB_VS2# 33
CBB_BVD1# 33

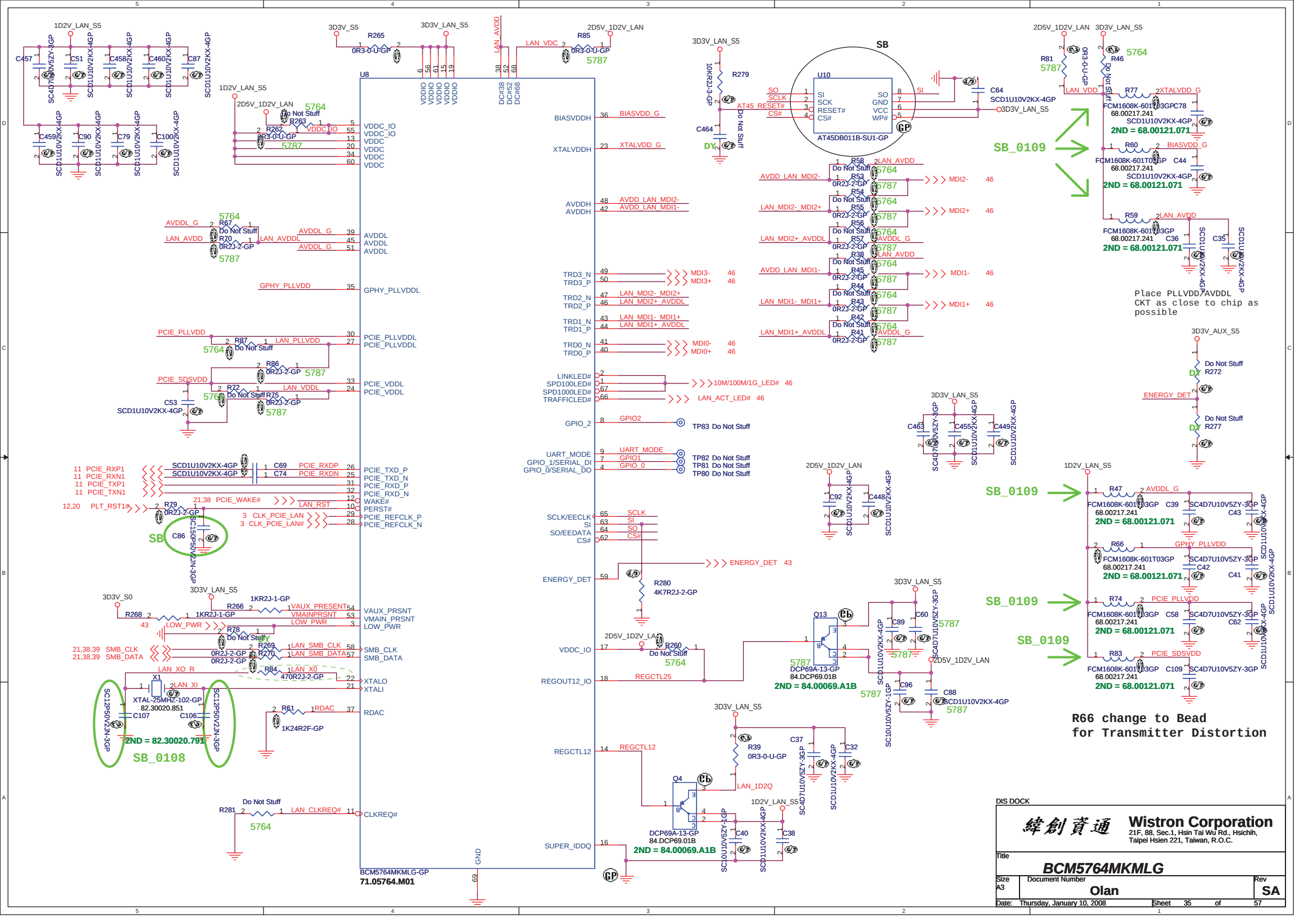
DIS DOCK

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: PCMCIA

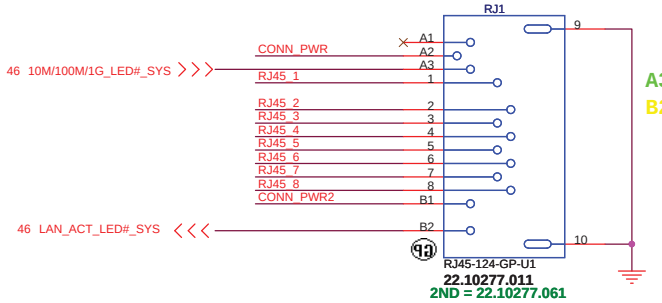
Size: A3 | Document Number: Olan | Rev: SA

Date: Thursday, January 10, 2008 | Sheet 34 of 57


U8
BCM5764MKMLG-GP
71.05764.M01
SB
SB_0108
SB_0109
SB_0109
SB_0109
2ND = 82.30020.791
2ND = 84.00069.A1B
2ND = 84.00121.A1B
2ND = 68.00121.071
Place PLLVDD/AVDDL CKT as close to chip as possible
R66 change to Bead for Transmitter Distortion
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
Title
BCM5764MKMLG
Size A3
Document Number
Olan
Rev SA
Date: Thursday, January 10, 2008
Sheet 35 of 57

LAN Connector

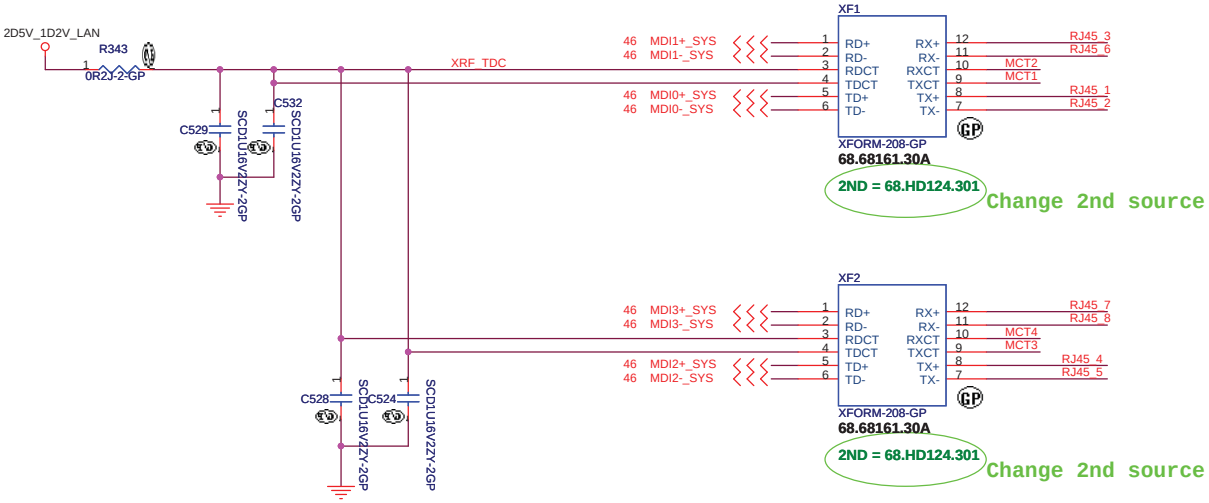
1.route on bottom as differential pairs.
2.Tx+/Tx- are pairs. Rx+/Rx- are pairs.
3.No vias, No 90 degree bends.
4.pairs must be equal lengths.
5.6mil trace width,12mil separation.
6.36mil between pairs and any other trace.
7.Must not cross ground moat,except
RJ-45 moat.

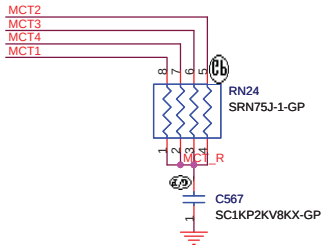


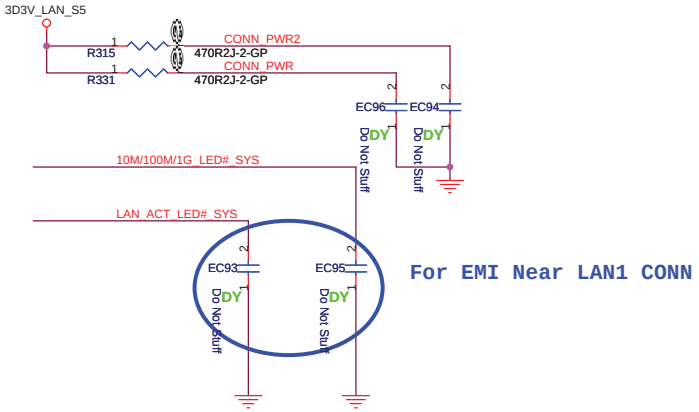
LAN Link: Green(A3), behavior is the same for 10/100/1000 bits

LAN Data: Yellow(B2), when LAN is transfering data.

GIGA Lan Transformer







DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title		
LAN CONN		
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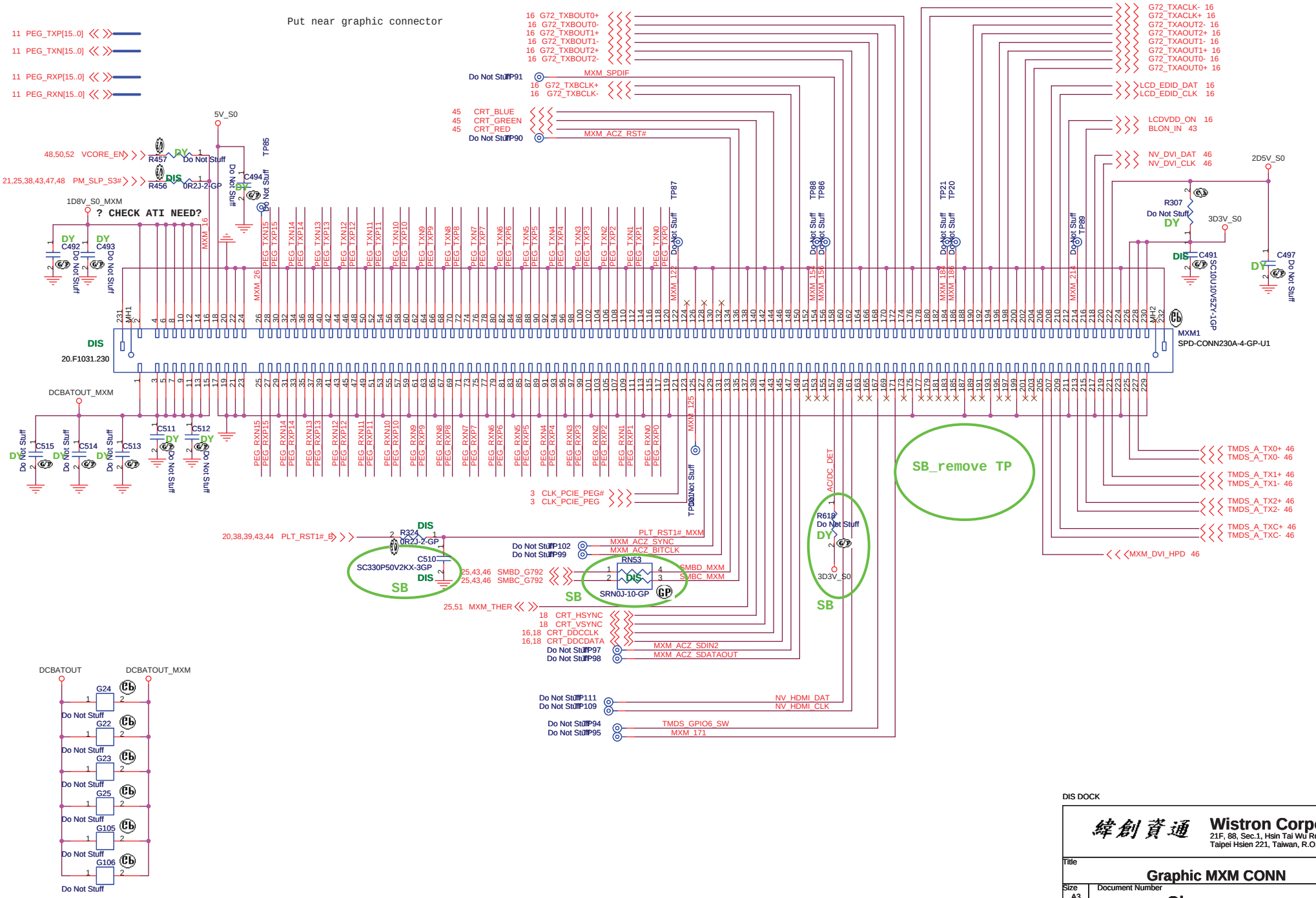
NV SMBus
A(pin143&145) : VGA(CRT) / DOCK
B(pin218&220) : DVI
C(pin208&210) : HDMI / TPI / LVDS



DIS DOCK

緯創資通 **Wistron Corporation**
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Taipei Hsien 221, Taiwan, R.O.C.

Title: **Graphic MXM CONN**

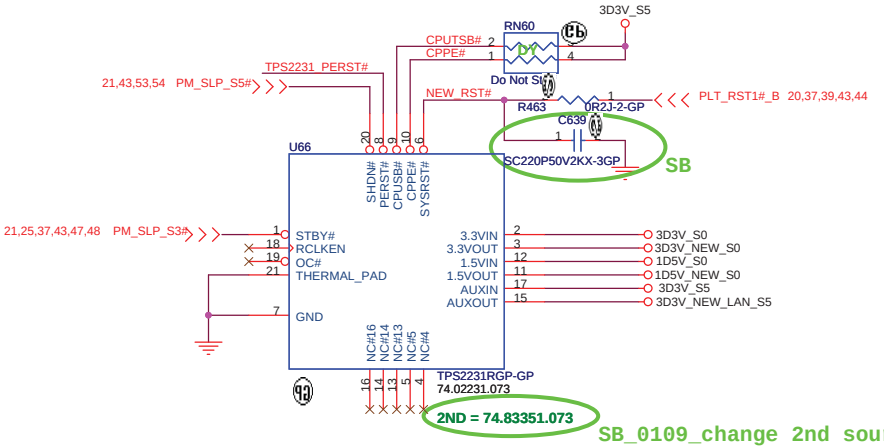
Size	Document Number	Rev
A3	Olan	SA

Date: Thursday, January 10, 2008 Sheet 37 of 57

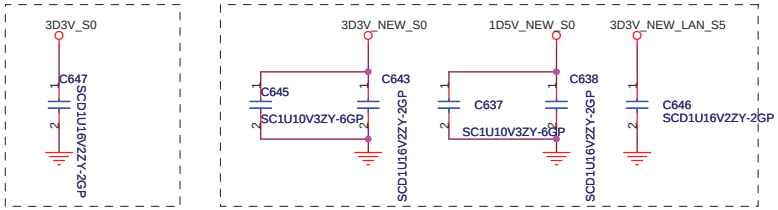
NEWCARD Connector

Reserve the symbol
for bottom side
connector

TOP VIEW



Place them Near to ChipPlace them Near to Connector



DIS DOCK

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: NEW CARD

Size	Document Number	Rev
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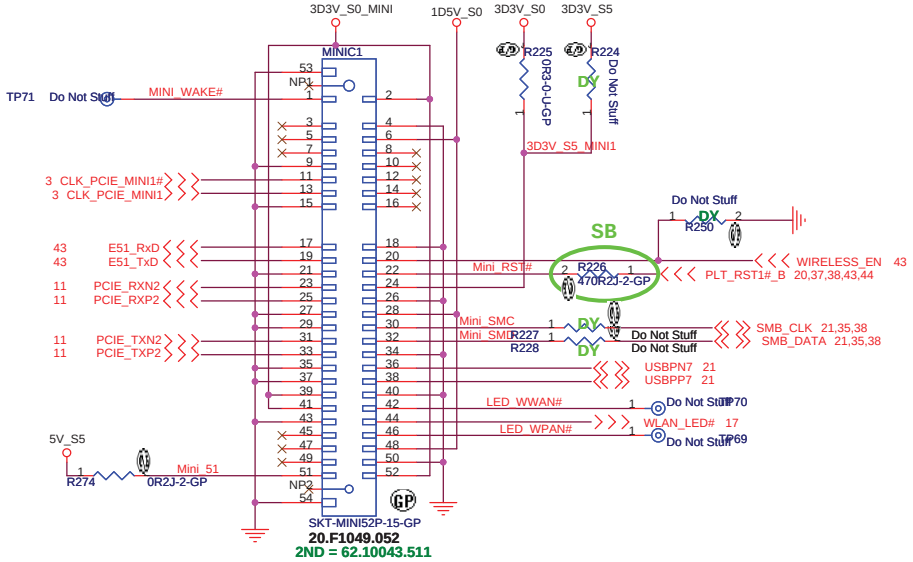
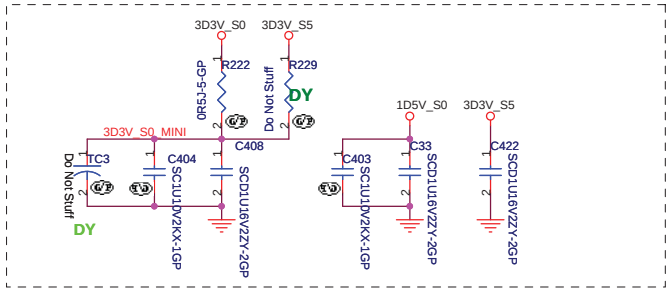
Mini Card Connector(WLAN)



Place near MINIC1



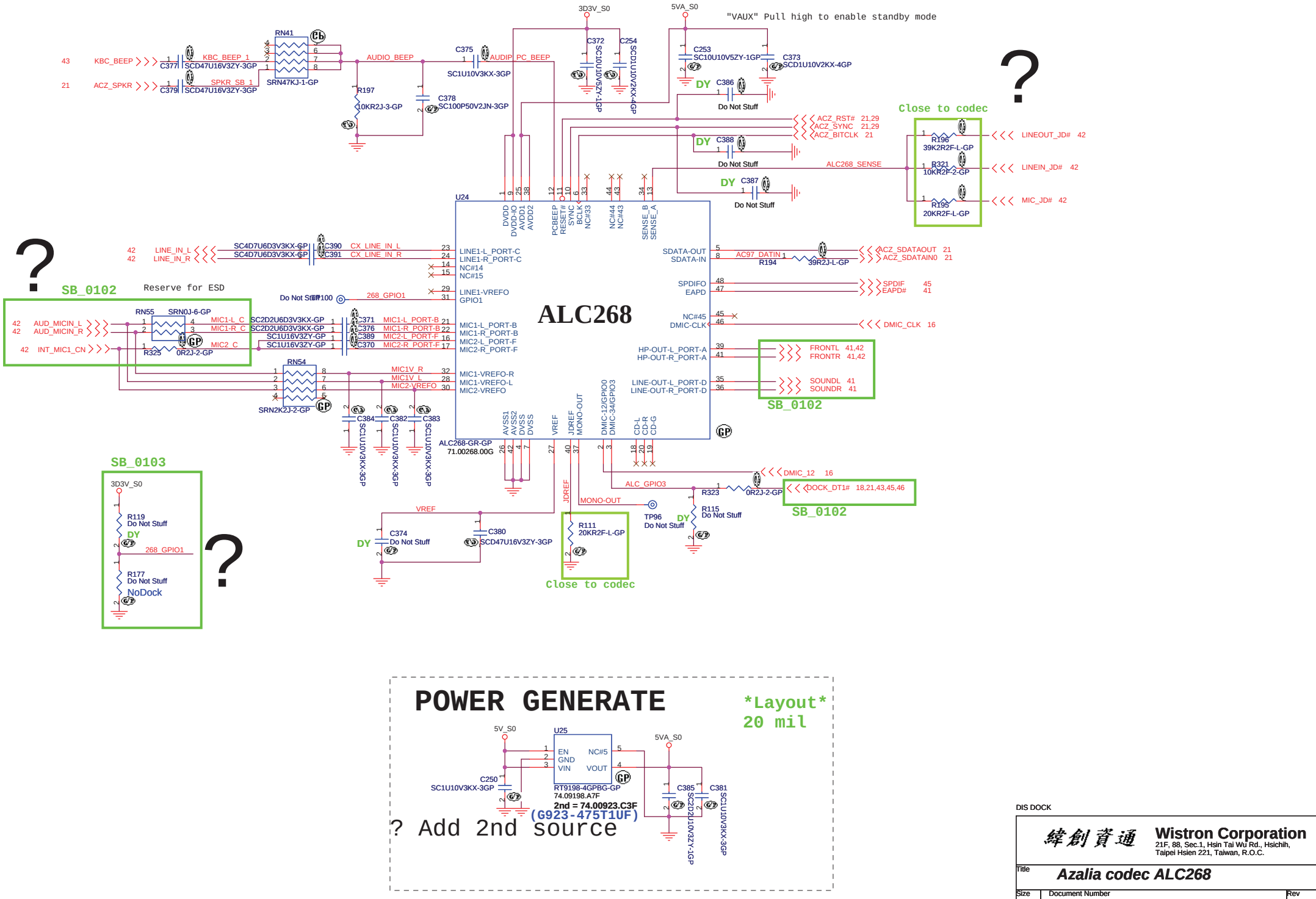
DIS DOCK

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Mini Card

Size: A3 | Document Number: Olan | Rev: SA

Date: Thursday, January 10, 2008 | Sheet 39 of 57


"VAUX" Pull high to enable standby mode
ALC268
U24
ALC268-GR-GP
71.00268.00G
SB_0102
Reserve for ESD
SB_0103
Close to codec
Do Not Stuff
DY
NoDock
POWER GENERATE
Layout
20 mil
U25
RT9198-4GPBG-GP
74.09198.A7F
2nd = 74.00923.C3F
(G923-475T1UF)
? Add 2nd source
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
Azalia codec ALC268
Size
A3
Document Number
Olan
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SA
Date: Thursday, January 10, 2008
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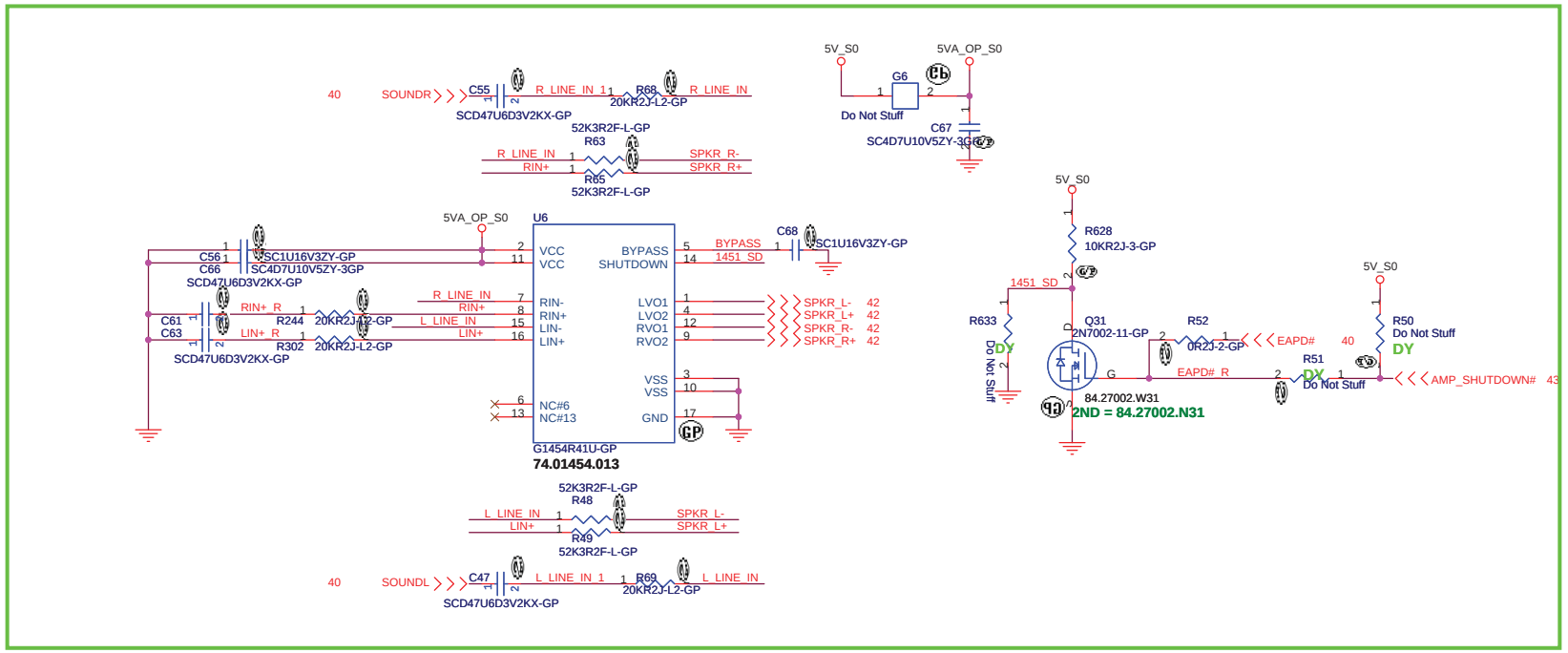
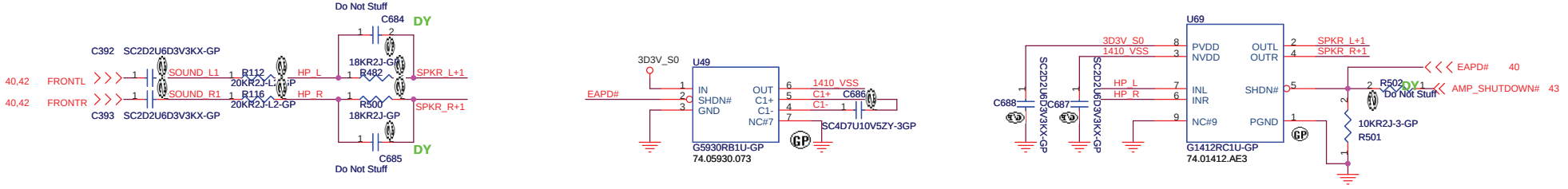
AUDIO OP AMPLIFIER

SB



SB

KBC_MUTE_GPIO8

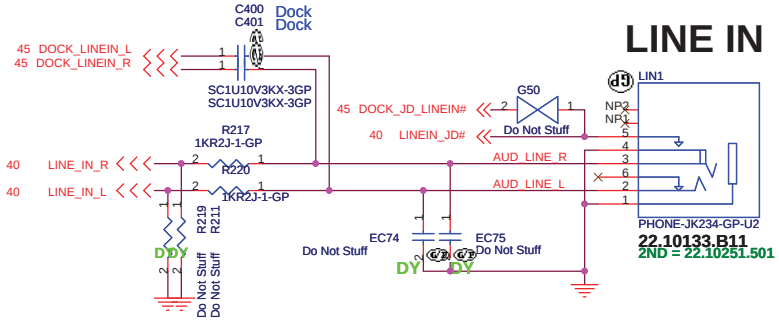


DIS DOCK

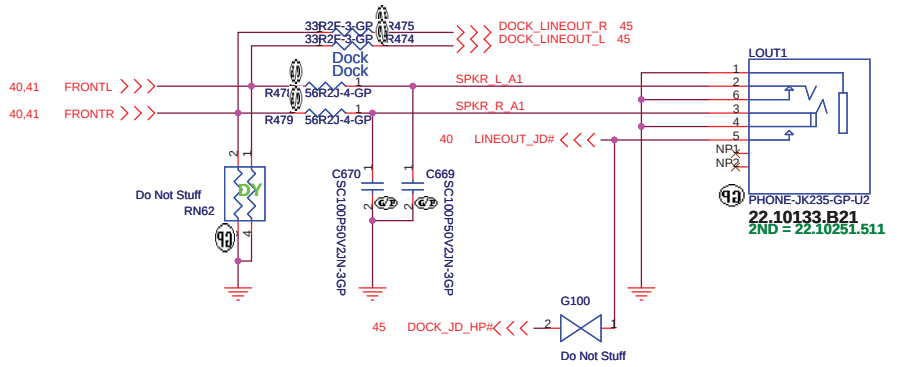
緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: AUDIO AMP		
Size: A3	Document Number: Olan	Rev: SB
Date: Thursday, January 10, 2008	Sheet 41 of 57	

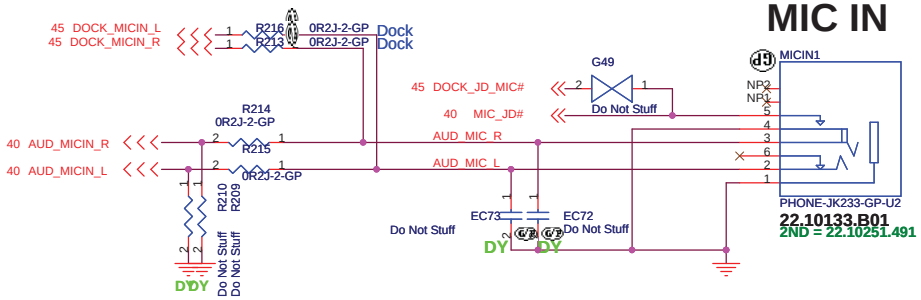
LINE IN



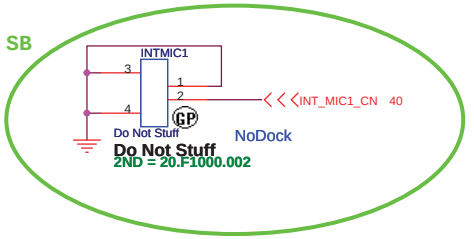
LINE OUT



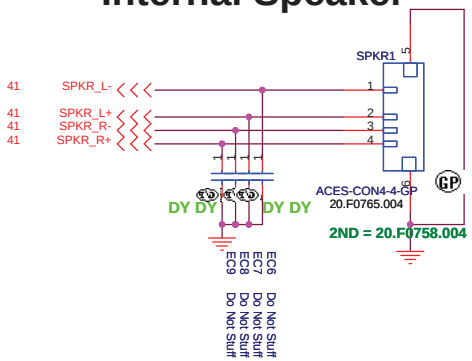
MIC IN



Internal MIC



Internal Speaker



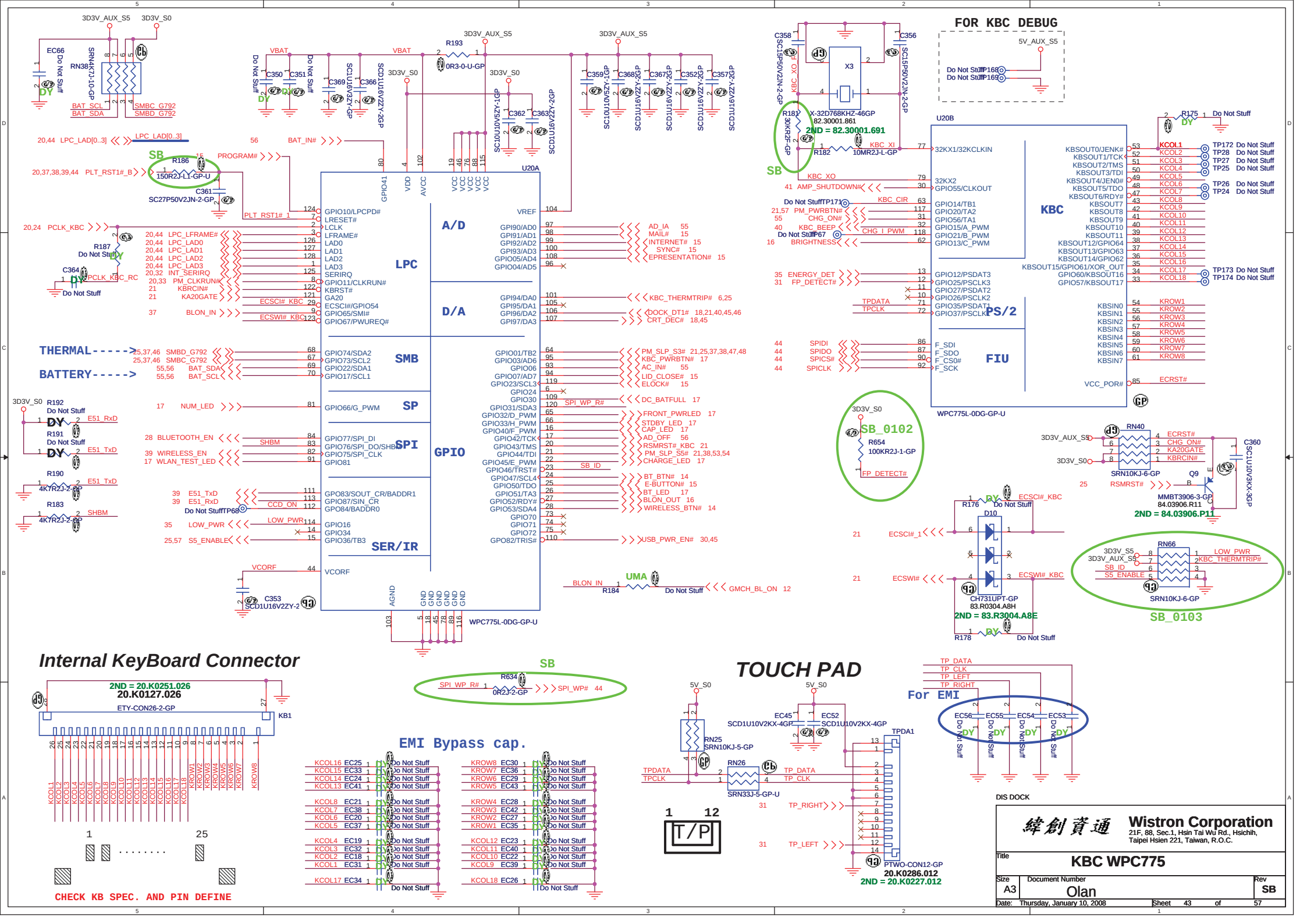
DIS DOCK

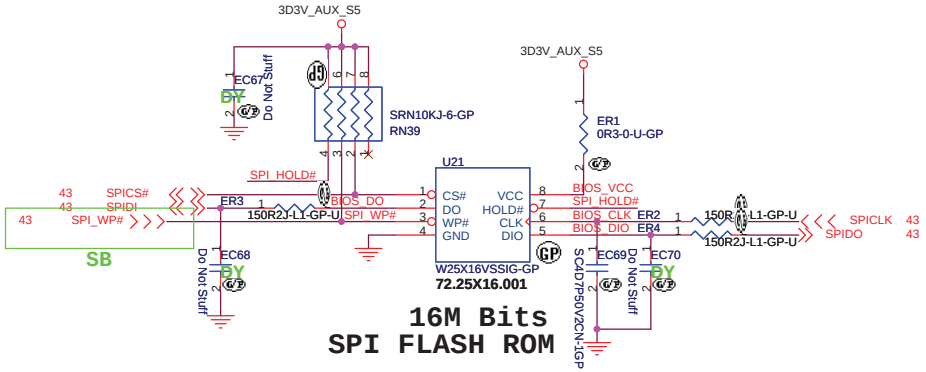
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

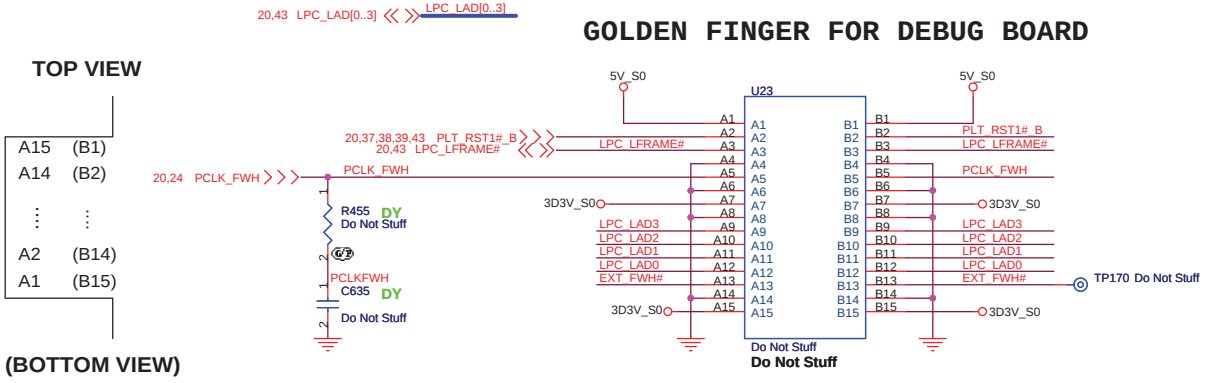
Title: AUDIO JACK

Size | Document Number: Olan | Rev: SB

Date: Thursday, January 10, 2008 | Sheet 42 of 57

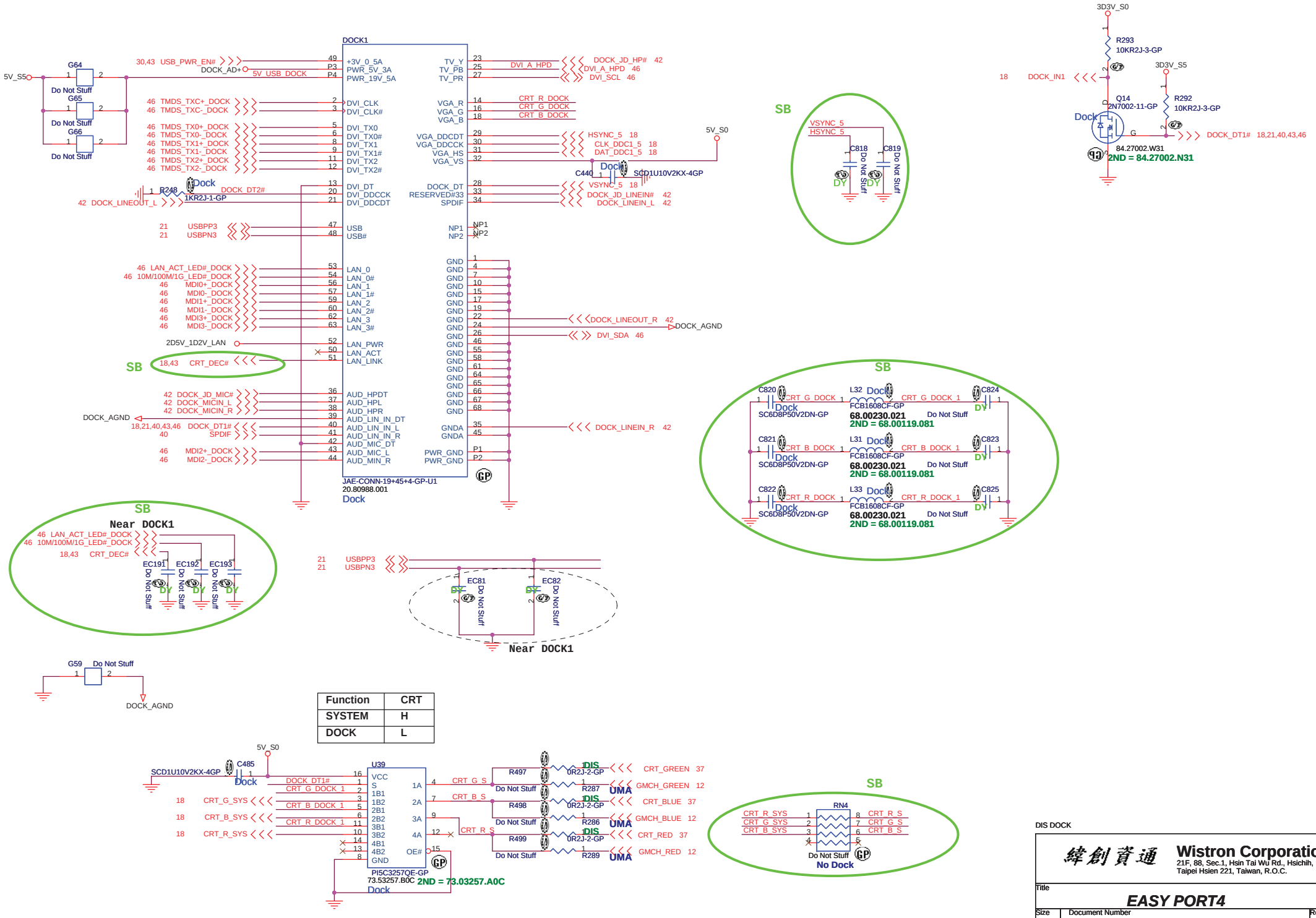

FOR KBC DEBUG
WPC775L-0DG-GP-U
KBC
PS/2
FIU
LPC
A/D
D/A
SMB
SP
SPI
GPIO
SER/IR
THERMAL----->
BATTERY----->
SB_0102
SB_0103
2ND = 82.30001.691
2ND = 84.03906.P11
2ND = 83.R3004.A8E
Internal KeyBoard Connector
2ND = 20.K0251.026
20.K0127.026
ETY-CON26-2-GP
CHECK KB SPEC. AND PIN DEFINE
EMI Bypass cap.
TOUCH PAD
For EMI
T/P
PTWO-CON12-GP
20.K0286.012
2ND = 20.K0227.012
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
KBC WPC775
Olan
Thursday, January 10, 2008





DIS DOCK

緯創資通 Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.		
Title: BIOS		
Size: A3	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 44 of 57	



Function	CRT
SYSTEM	H
DOCK	L

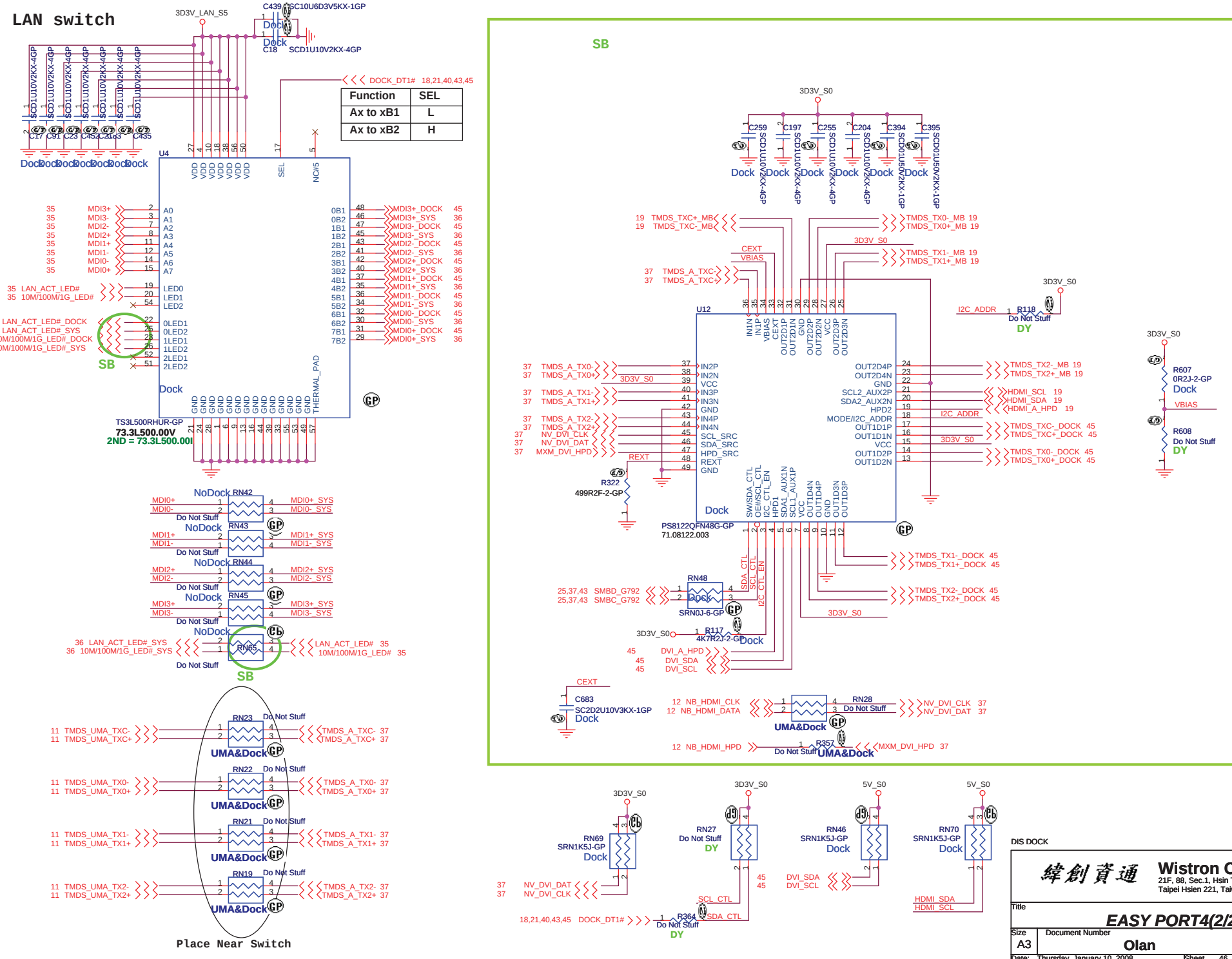
DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

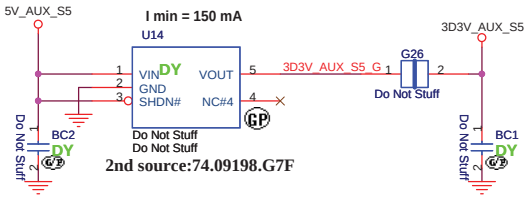
Title: **EASY PORT4**

Size	Document Number	Rev
A3	Olan	SA

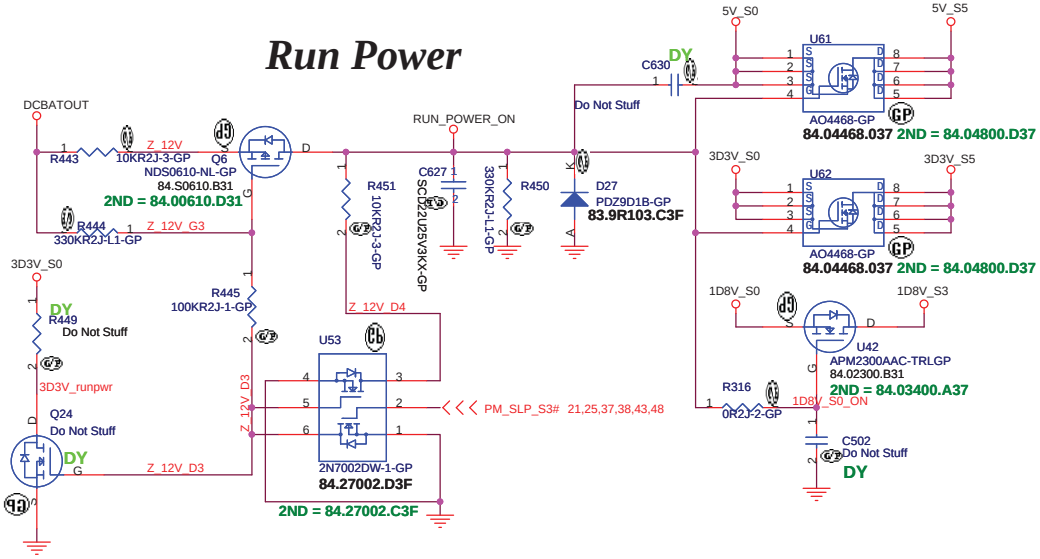
Date: Thursday, January 10, 2008 Sheet 45 of 57


LAN switch
3D3V_LAN_S5
C439 SC10U6D3V5KX-1GP
C18 SCD1U10V2KX-4GP
DOCK_DT1# 18,21,40,43,45
Function SEL
Ax to xB1 L
Ax to xB2 H
U4
SEL
NC#5
MDI3+ MDI3- MDI2- MDI2+ MDI1+ MDI1- MDI0- MDI0+
LAN_ACT_LED#
10M/100M/1G_LED#
LAN_ACT_LED#_DOCK
LAN_ACT_LED#_SYS
10M/100M/1G_LED#_DOCK
10M/100M/1G_LED#_SYS
SB
Dock
THERMAL_PAD
TS3L500RHUR-GP
73.3L500.00V
2ND = 73.3L500.00I
NoDock RN42
NoDock RN43
NoDock RN44
NoDock RN45
NoDock RN65
Do Not Stuff
SB
RN23
RN22
RN21
RN19
UMA&Dock
TMDS_UMA_TXC-
TMDS_UMA_TXC+
TMDS_UMA_TX0-
TMDS_UMA_TX0+
TMDS_UMA_TX1-
TMDS_UMA_TX1+
TMDS_UMA_TX2-
TMDS_UMA_TX2+
Place Near Switch
SB
3D3V_S0
U12
PS8122QFN48G-GP
71.08122.003
TMDS_A_TX0- TMDS_A_TX0+
TMDS_A_TX1- TMDS_A_TX1+
TMDS_A_TX2- TMDS_A_TX2+
TMDS_A_TXC- TMDS_A_TXC+
NV_DVI_CLK NV_DVI_DAT MXM_DVI_HPD
REXT
R322 499R2F-2-GP
R118 Do Not Stuff DY
R607 0R2J-2-GP
R608 Do Not Stuff DY
RN48 SRN0J-6-GP
R117 4K7R2J-2-GP
SMBD_G792 SMBC_G792
DVI_A_HPD DVI_SDA DVI_SCL
C683 SC2D2U10V3KX-1GP
RN28 Do Not Stuff
R357 Do Not Stuff
NB_HDMI_CLK NB_HDMI_DATA NB_HDMI_HPD
RN69 SRN1K5J-GP
RN27 Do Not Stuff DY
RN46 SRN1K5J-GP
RN70 SRN1K5J-GP
R364 Do Not Stuff DY
5V_S0
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
EASY PORT4(2/2)
Size A3
Document Number Olan
Rev SA
Date: Thursday, January 10, 2008
Sheet 46 of 57

Aux Power 3D3V_AUX_S5

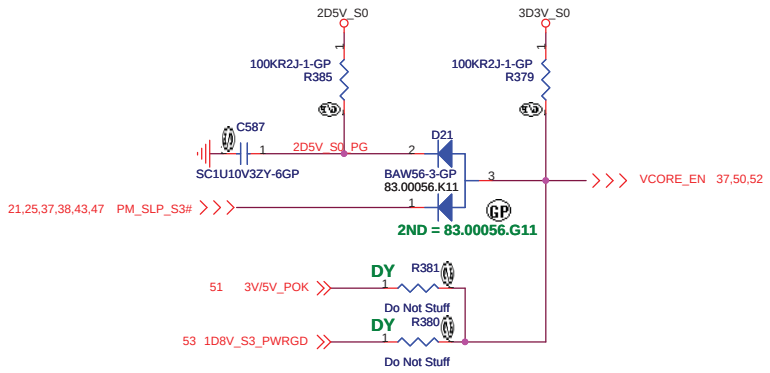


Run Power

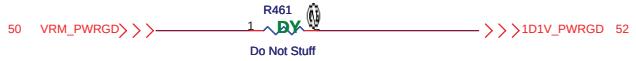


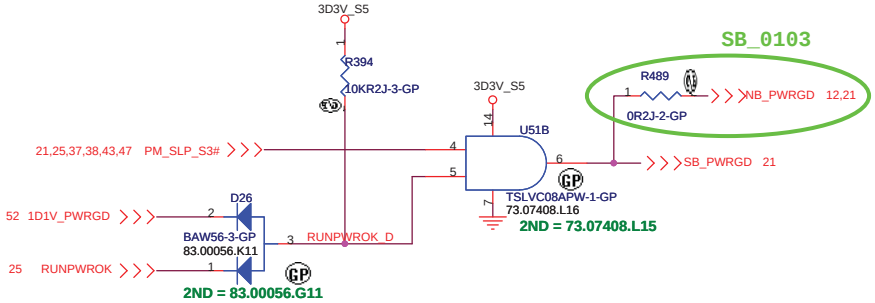
DIS DOCK

緯創資通 Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.		
Title: RUN POWER and 3D3V_AUX_S5		
Size: A3	Document Number: Olan	Rev: SA
Date: Thursday, January 10, 2008	Sheet 47 of 57	



P/H @ 1D8V_S3 PAGE





DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: ***POWER ON LOGIC***

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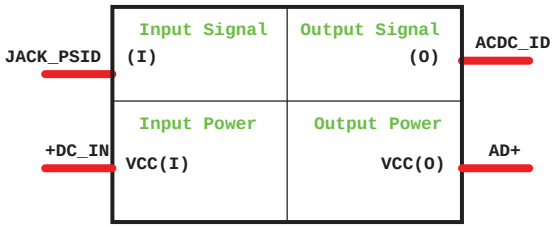
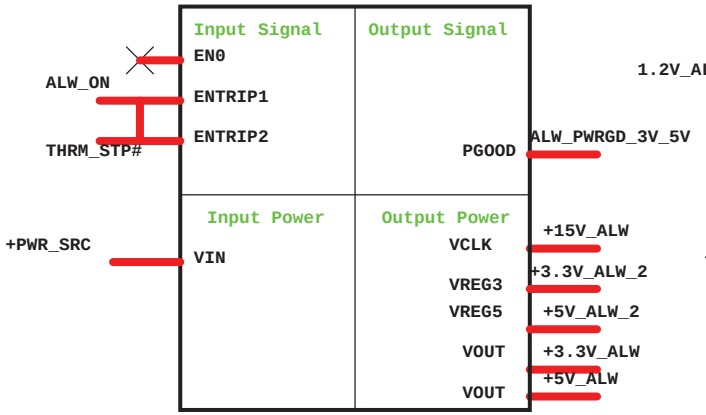
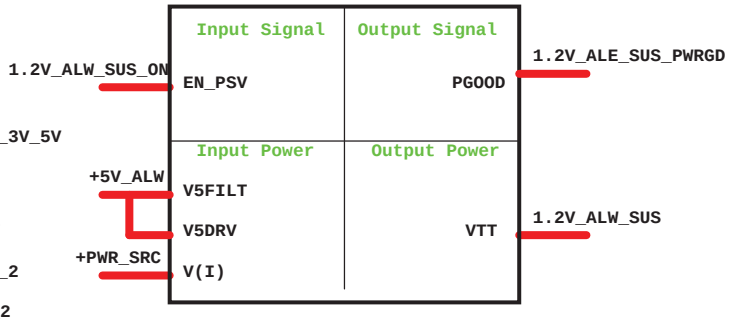
Adapter



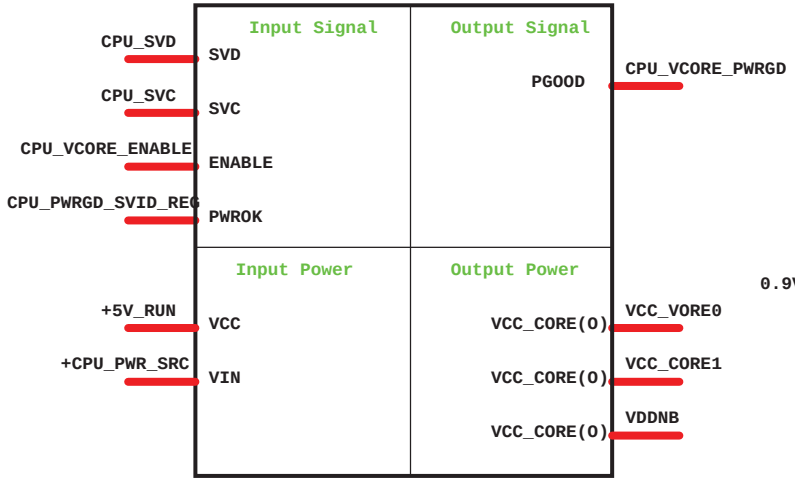
SN0608098



DCDC 1D2V(TPS5117)

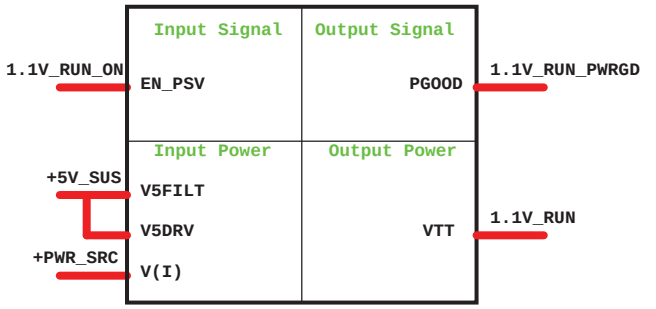


CPU_CORE
ISL6265HRTZ

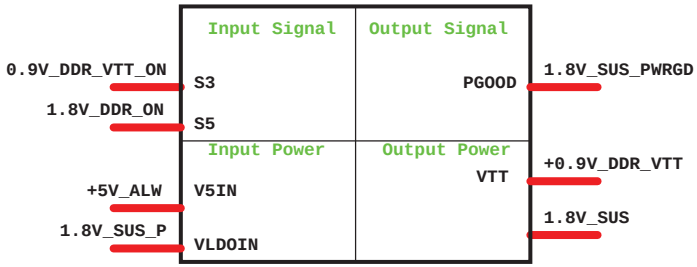


	S3	S5	VDDQ	VTTREF	VTT
S0 S3	1	1	1	1	1
S4 S5	0	0	0	0	0

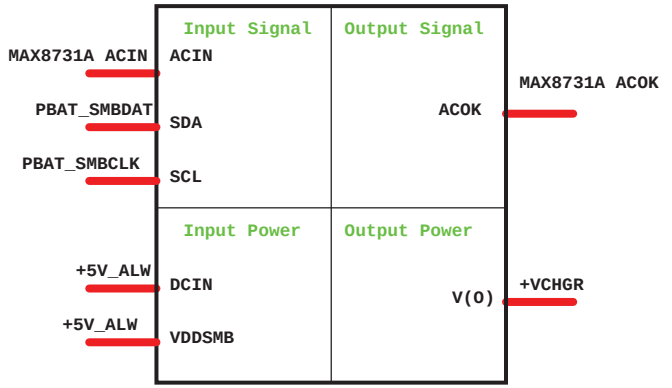
1D1V(TPS5117)



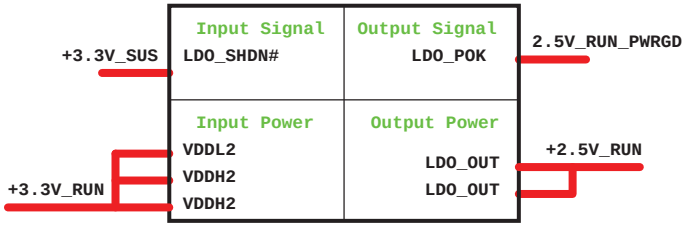
1D8V/0D9V(TPS5116)



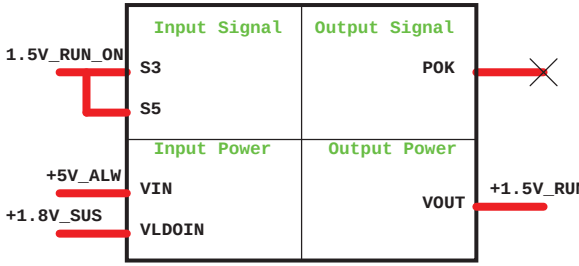
CHARGER BQ24745



2.5V LDO
EMC4002



1.5V_LDO



DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: **Power Block Diagram**

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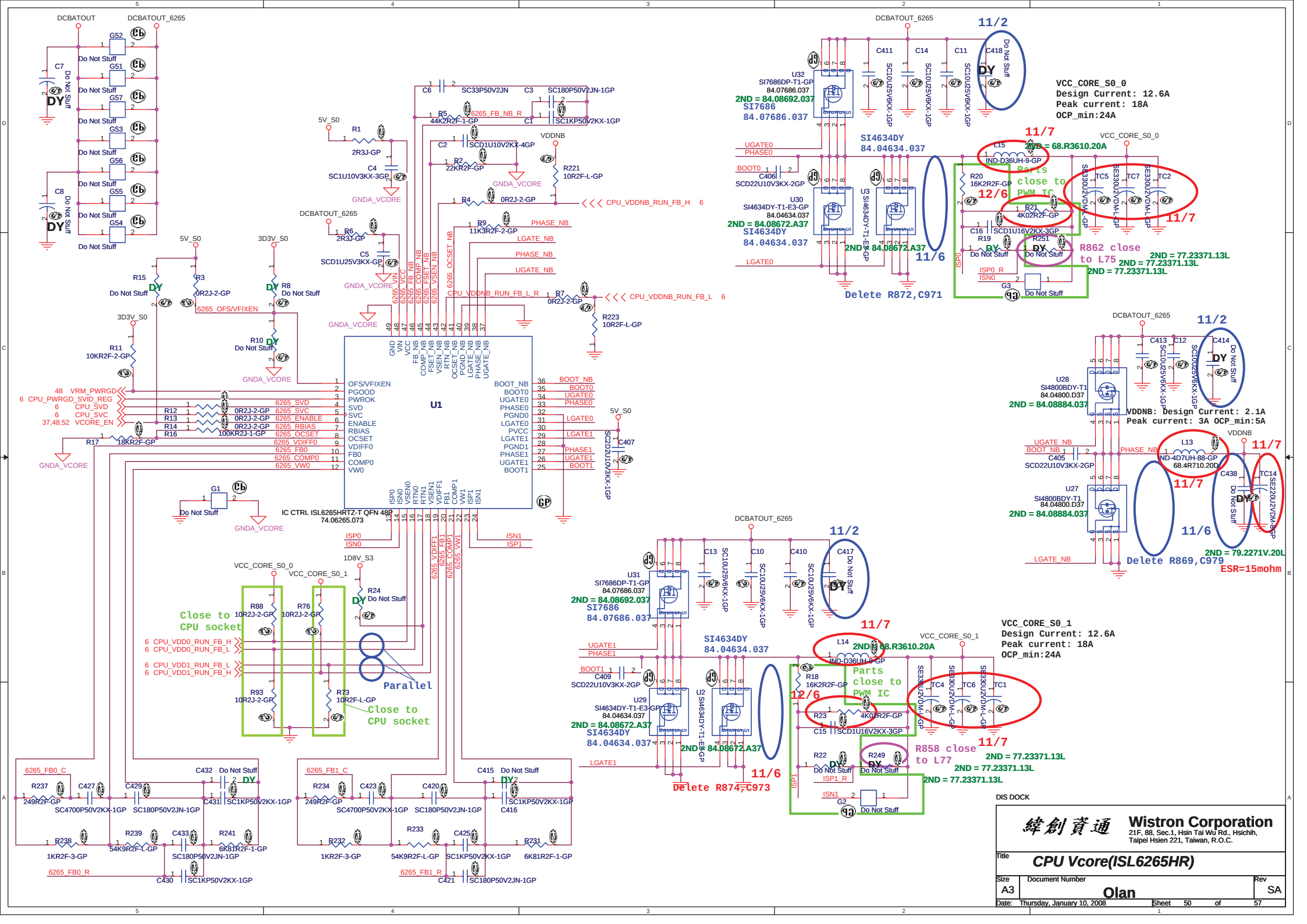
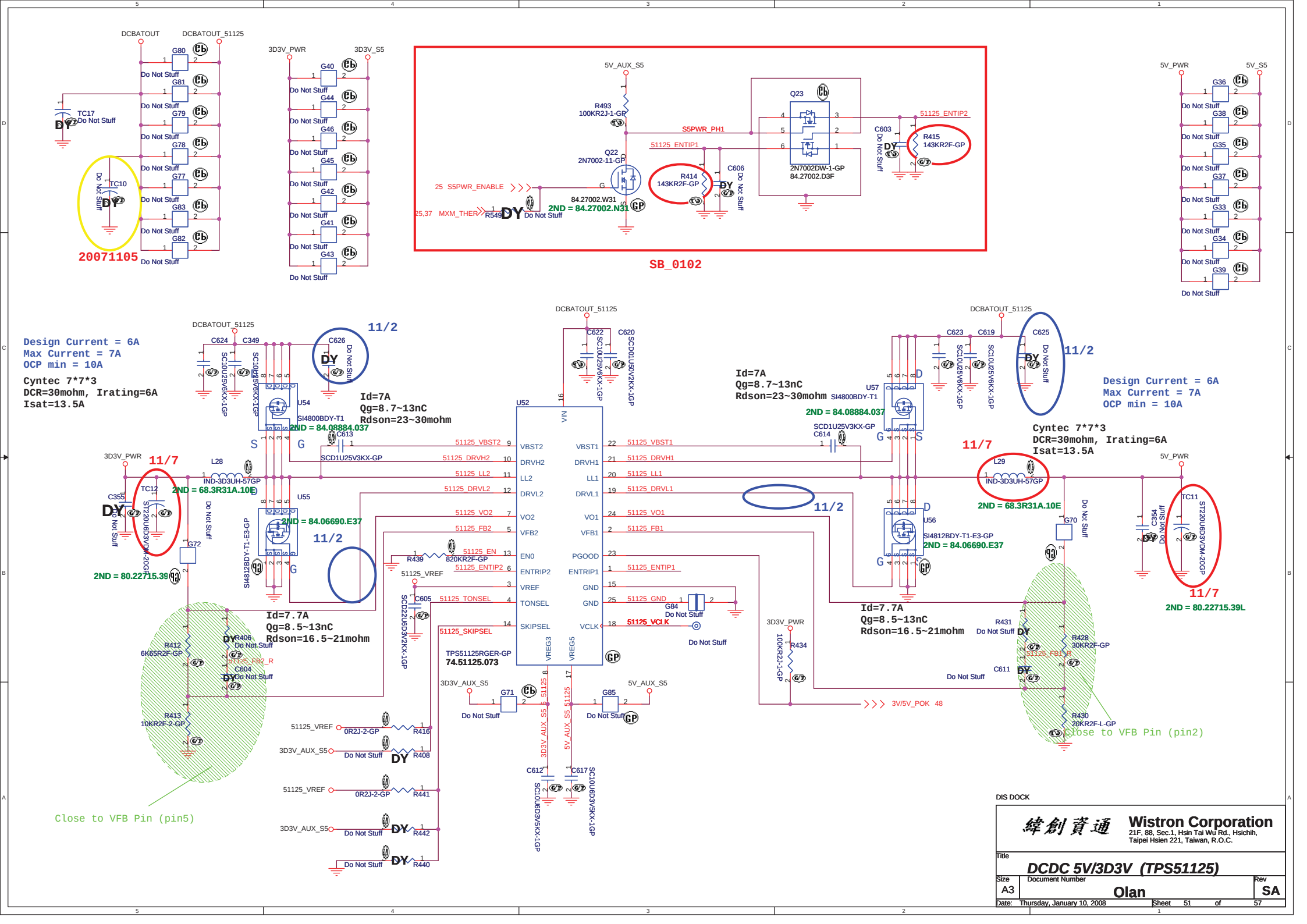

U1
IC CTRL ISL6265HRTZ-T QFN 48P
74.06265.073
U32
SI7686DP-T1-GP
84.07686.037
2ND = 84.08692.037
SI7686
84.07686.037
U30
SI4634DY-T1-E3-GP
84.04634.037
2ND = 84.08672.A37
SI4634DY
84.04634.037
U3
SI4634DY-T1-E3-GP
SI4634DY
84.04634.037
2ND = 84.08672.A37
Delete R872,C971
VCC_CORE_S0_0
Design Current: 12.6A
Peak current: 18A
OCP_min:24A
L15
IND-D36UH-9-GP
2ND = 68.R3610.20A
Parts close to PWM IC
R862 close to L75
2ND = 77.23371.13L
U31
SI7686DP-T1-GP
84.07686.037
2ND = 84.08692.037
SI7686
84.07686.037
U29
SI4634DY-T1-E3-GP
84.04634.037
2ND = 84.08672.A37
SI4634DY
84.04634.037
U2
SI4634DY-T1-E3-GP
SI4634DY
84.04634.037
2ND = 84.08672.A37
Delete R874,C973
VCC_CORE_S0_1
Design Current: 12.6A
Peak current: 18A
OCP_min:24A
L14
2ND = 68.R3610.20A
IND-D36UH-9-GP
Parts close to PWM IC
R858 close to L77
2ND = 77.23371.13L
U28
SI4800BDY-T1
84.04800.D37
2ND = 84.08884.037
U27
SI4800BDY-T1
84.04800.D37
2ND = 84.08884.037
VDDNB: Design Current: 2.1A
Peak current: 3A OCP_min:5A
L13
IND-4D7UH-88-GP
68.4R710.20D
2ND = 79.2271V.20L
ESR=15mohm
Delete R869,C979
Close to CPU socket
Parallel
Close to CPU socket
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
CPU Vcore(ISL6265HR)
Size
A3
Document Number
Olan
Rev
SA
Date: Thursday, January 10, 2008
Sheet 50 of 57


DCBATOUT
DCBATOUT_51125
3D3V_PWR
3D3V_S5
5V_AUX_S5
5V_PWR
5V_S5
Do Not Stuff
20071105
SB_0102
S5PWR_PH1
51125_ENTIP1
51125_ENTIP2
25 S5PWR_ENABLE
25,37 MXM_THER
2ND = 84.27002.N31
Design Current = 6A
Max Current = 7A
OCP min = 10A
Cyntec 7*7*3
DCR=30mohm, Irating=6A
Isat=13.5A
Id=7A
Qg=8.7~13nC
Rdson=23~30mohm
2ND = 84.08884.037
2ND = 84.08690.E37
2ND = 68.3R31A.10E
2ND = 80.22715.39L
Id=7.7A
Qg=8.5~13nC
Rdson=16.5~21mohm
TPS51125RGER-GP
74.51125.073
3V/5V_POK 48
Close to VFB Pin (pin5)
Close to VFB Pin (pin2)
11/2
11/7
DIS DOCK
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
DCDC 5V/3D3V (TPS51125)
Olan
Size A3
Rev SA
Date: Thursday, January 10, 2008
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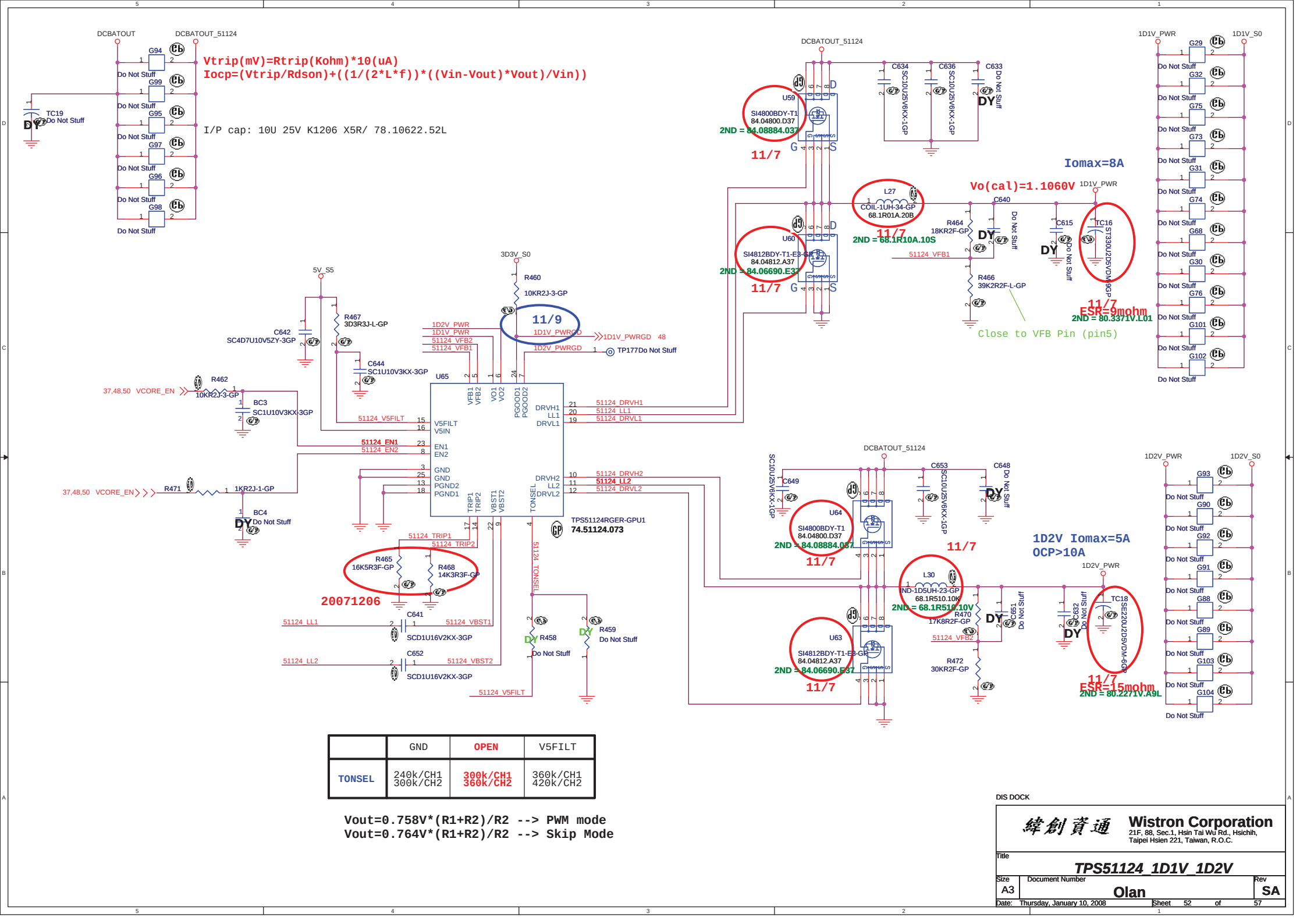
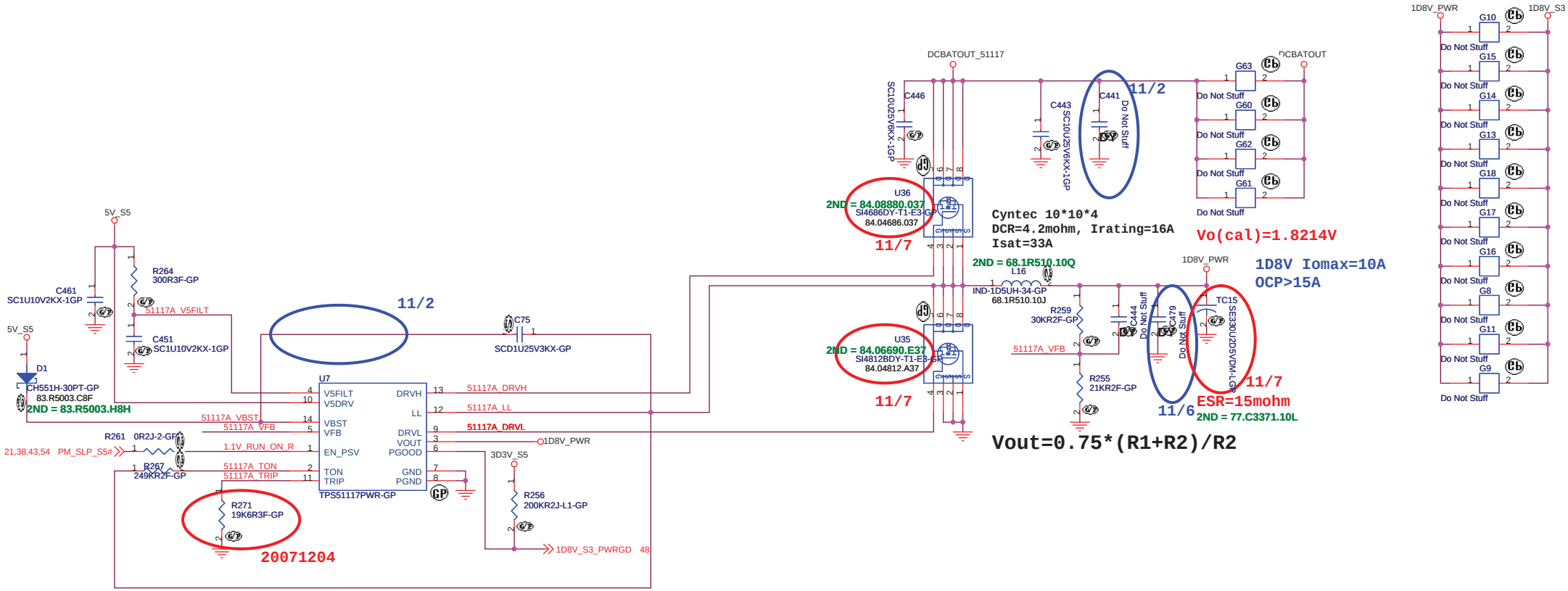


	GND	OPEN	V5FILT
TONSEL	240k/CH1 300k/CH2	300k/CH1 360k/CH2	360k/CH1 420k/CH2



DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: ***1D8V(TPS5117)***

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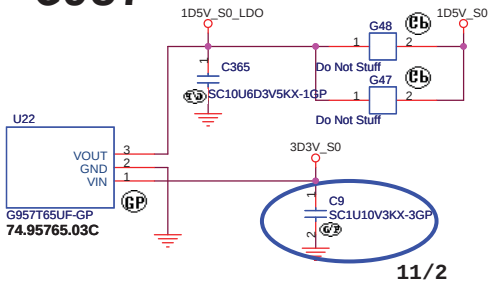
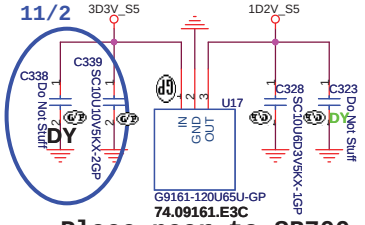
1D5V_S0
Iomax=1A

G957

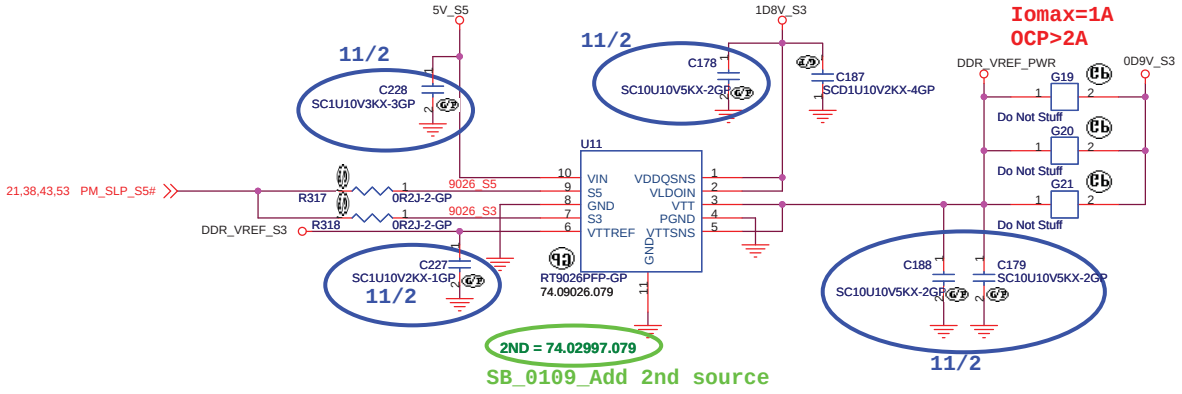


11/2

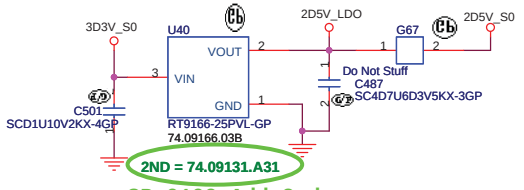
1D2V_S5
Iomax=400mA



Place near to SB700



2D5V_S0
Iomax=0.3A 2D5V/300mA



SB_0109_Add 2nd source

DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: ***0D9V&2D5V&1D25V&1D5V***

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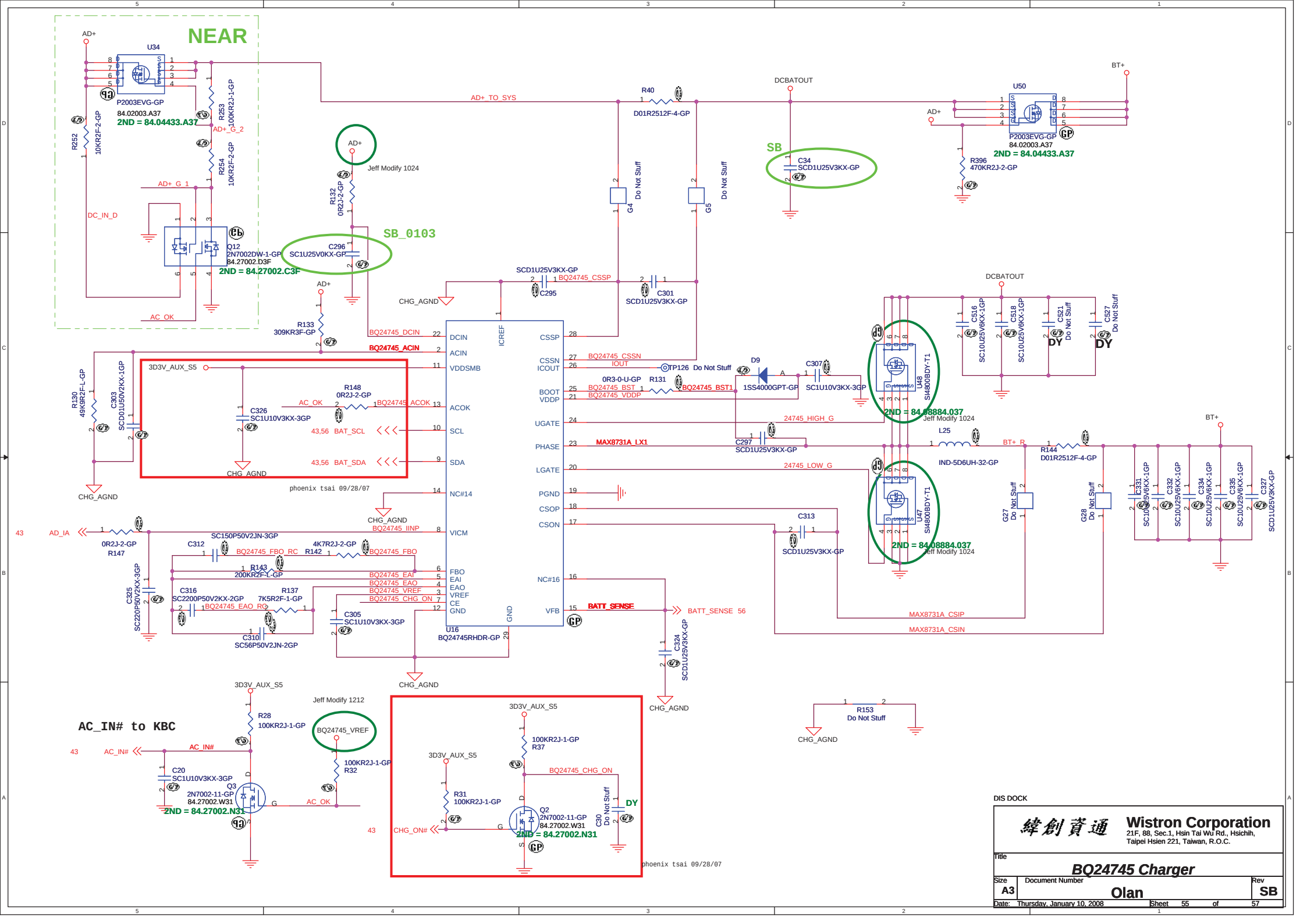
NEAR
U34
P2003EVG-GP
84.02003.A37
2ND = 84.04433.A37
R252 10KR2F-2-GP
R253 100KR2J-1-GP
R254 10KR2F-2-GP
AD+_G_2
AD+_G_1
DC_IN_D
Q12
2N7002DW-1-GP
84.27002.D3F
2ND = 84.27002.C3F
AC_OK
AD+
AD+_TO_SYS
R40
D01R2512F-4-GP
DCBATOUT
SB
C34
SCD1U25V3KX-GP
U50
P2003EVG-GP
84.02003.A37
2ND = 84.04433.A37
R396
470KR2J-2-GP
BT+
Jeff Modify 1024
R132
0R2J-2-GP
SB_0103
C296
SC1U25V0KX-GP
G4
G5
Do Not Stuff
SCD1U25V3KX-GP
C295
C301
SCD1U25V3KX-GP
BQ24745_CSSP
CHG_AGND
R133
309KR3F-GP
BQ24745_DCIN
BQ24745_ACIN
3D3V_AUX_S5
R130
49K9R2F-L-GP
C303
SCD01U50V2KX-1GP
R148
0R2J-2-GP
AC_OK
BQ24745_ACOK
C326
SC1U10V3KX-3GP
43,56 BAT_SCL
43,56 BAT_SDA
phoenix tsai 09/28/07
ICREF
DCIN
ACIN
VDDSMB
ACOK
SCL
SDA
NC#14
VICM
FBO
EAI
EAO
VREF
CE
GND
CSSP
CSSN
ICOUT
BOOT
VDDP
UGATE
PHASE
LGATE
PGND
CSOP
CSON
NC#16
VFB
U16
BQ24745RHDR-GP
BQ24745_CSSN
IOUT
TP126 Do Not Stuff
BQ24745_BST
BQ24745_VDDP
0R3-0-U-GP
R131
BQ24745_BST1
D9
1SS4000GPT-GP
C307
SC1U10V3KX-3GP
24745_HIGH_G
24745_LOW_G
MAX8731A_LX1
C297
SCD1U25V3KX-GP
L25
IND-5D6UH-32-GP
BT+_R
R144
D01R2512F-4-GP
U48
SI4800BDY-T1
U47
SI4800BDY-T1
2ND = 84.08884.037
Jeff Modify 1024
C516
SC10U25V6KX-1GP
C518
SC10U25V6KX-1GP
C521
Do Not Stuff
C527
Do Not Stuff
DY
G27
G28
C331
C332
C334
C335
C327
SCD1U25V3KX-GP
C313
SCD1U25V3KX-GP
MAX8731A_CSIP
MAX8731A_CSIN
BATT_SENSE
BATT_SENSE 56
C324
SCD1U25V3KX-GP
AD_IA
0R2J-2-GP
R147
SC150P50V2JN-3GP
C312
BQ24745_FBO_RC
4K7R2J-2-GP
R142
BQ24745_FBO
R143
200KR2F-L-GP
C325
SC220P50V2KX-3GP
C316
SC2200P50V2KX-2GP
BQ24745_EAO_RC
R137
7K5R2F-1-GP
C310
SC56P50V2JN-2GP
C305
SC1U10V3KX-3GP
BQ24745_IINP
BQ24745_EAI
BQ24745_EAO
BQ24745_VREF
BQ24745_CHG_ON
R153
Do Not Stuff
AC_IN# to KBC
AC_IN#
C20
SC1U10V3KX-3GP
Q3
2N7002-11-GP
84.27002.W31
2ND = 84.27002.N31
R28
100KR2J-1-GP
R32
100KR2J-1-GP
Jeff Modify 1212
R37
100KR2J-1-GP
R31
100KR2J-1-GP
Q2
2N7002-11-GP
84.27002.W31
2ND = 84.27002.N31
C30
Do Not Stuff
CHG_ON#
DIS DOCK
緯創資通
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
Title
BQ24745 Charger
Size
A3
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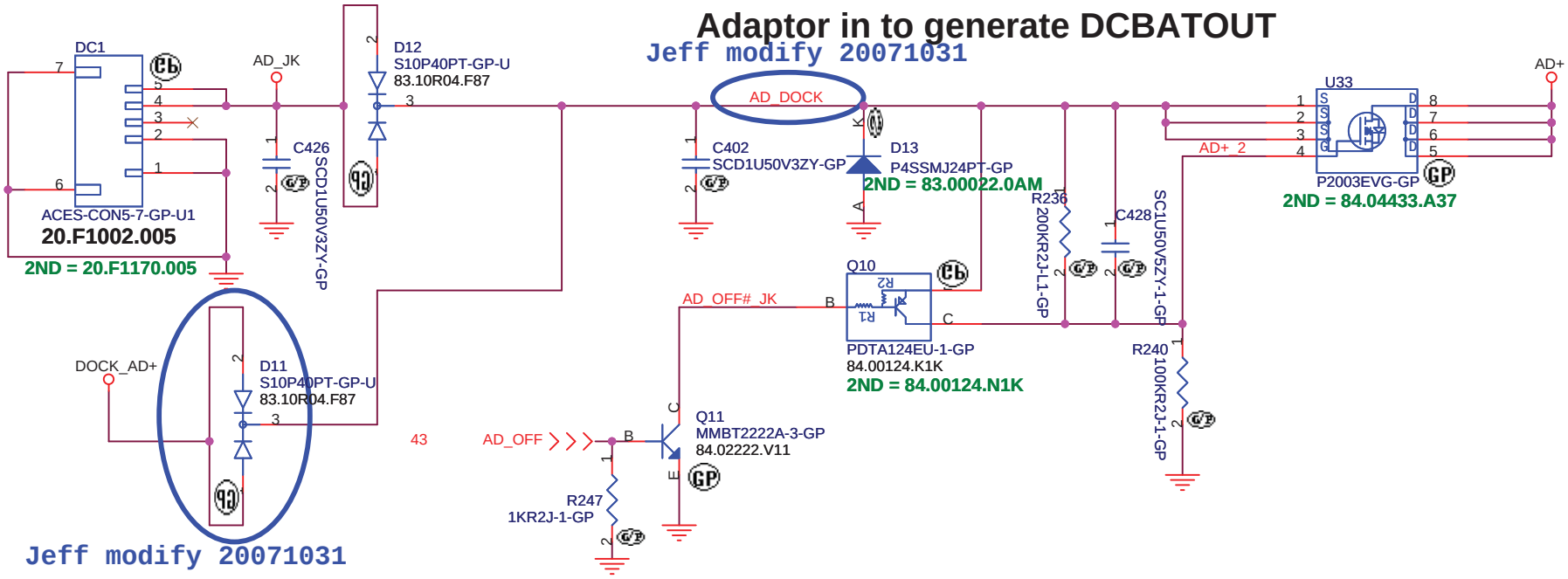
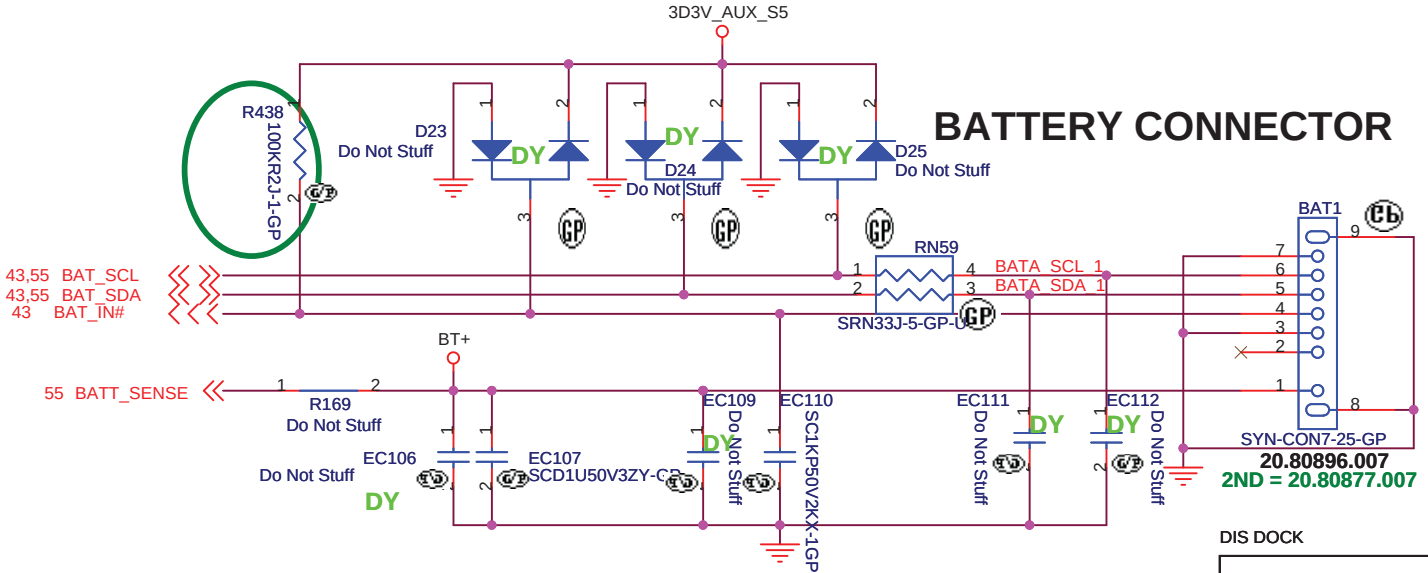
Adaptor in to generate DCBATOUT

Jeff modify 20071031



Jeff modify 20071031

BATTERY CONNECTOR



DIS DOCK

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	***AD/BATT CONN***	
Size **A4**	Document Number **Olan**	Rev SA
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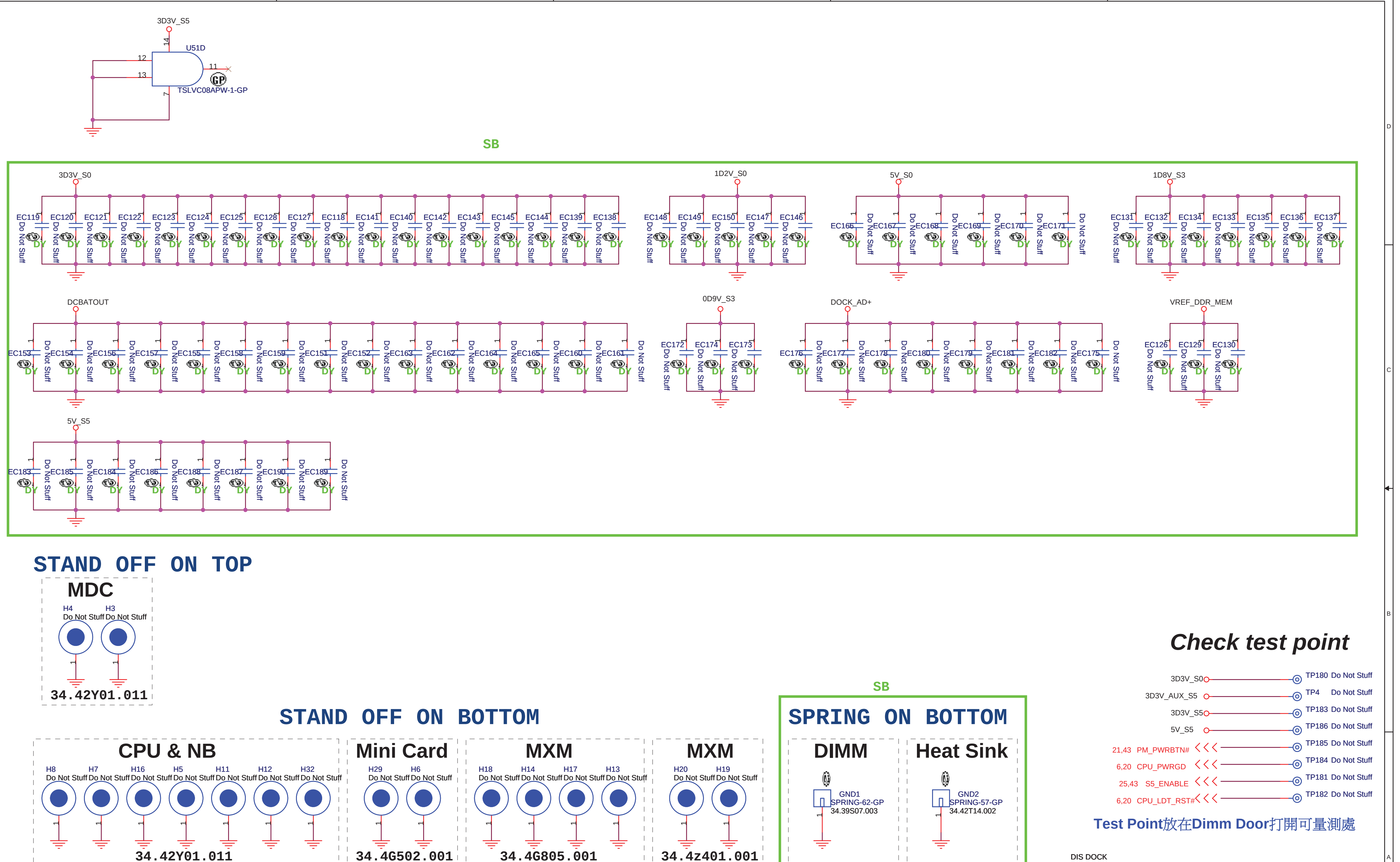
3D3V_S5
U51D
TSLVC08APW-1-GP
SB
3D3V_S0
1D2V_S0
5V_S0
1D8V_S3
DCBATOUT
0D9V_S3
DOCK_AD+
VREF_DDR_MEM
5V_S5
EC119 EC120 EC121 EC122 EC123 EC124 EC125 EC128 EC127 EC118 EC141 EC140 EC142 EC143 EC145 EC144 EC139 EC138
EC148 EC149 EC150 EC147 EC146
EC166 EC167 EC168 EC169 EC170 EC171
EC131 EC132 EC134 EC133 EC135 EC136 EC137
EC153 EC154 EC156 EC157 EC155 EC158 EC159 EC151 EC152 EC163 EC162 EC164 EC165 EC160 EC161
EC172 EC174 EC173
EC176 EC177 EC178 EC180 EC179 EC181 EC182 EC175
EC126 EC129 EC130
EC183 EC185 EC184 EC186 EC188 EC187 EC190 EC189
Do Not Stuff
STAND OFF ON TOP
MDC
H4 H3
34.42Y01.011
STAND OFF ON BOTTOM
CPU & NB
H8 H7 H16 H5 H11 H12 H32
34.42Y01.011
Mini Card
H29 H6
34.4G502.001
MXM
H18 H14 H17 H13
34.4G805.001
MXM
H20 H19
34.4z401.001
SB
SPRING ON BOTTOM
DIMM
GND1
SPRING-62-GP
34.39S07.003
Heat Sink
GND2
SPRING-57-GP
34.42T14.002
H1 H22 H25 H15 H21 H33 H27 H31 H30 H2 H10 H9 H28 H26 H23
Check test point
3D3V_S0 TP180 Do Not Stuff
3D3V_AUX_S5 TP4 Do Not Stuff
3D3V_S5 TP183 Do Not Stuff
5V_S5 TP186 Do Not Stuff
21,43 PM_PWRBTN# TP185 Do Not Stuff
6,20 CPU_PWRGD TP184 Do Not Stuff
25,43 S5_ENABLE TP181 Do Not Stuff
6,20 CPU_LDT_RST# TP182 Do Not Stuff
Test Point放在Dimm Door打開可量測處

DIS DOCK

緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.

Title: **EMI/Spring/Boss**

Size: A3 | Document Number: Olan | Rev: SB

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